1 GSPS Quadrature Digital Upconverter with 18-Bit I/Q Data Path and 14-Bit DAC

Data Sheet

AD9957

FEATURES

1 GSPS internal clock speed (up to 400 MHz analog output)
Integrated 1 GSPS 14-bit DAC
250 MSPS input data rate
Phase noise ≤ −125 dBc/Hz (400 MHz carrier @ 1 kHz offset)
Excellent dynamic performance >80 dB narrow-band SFDR
8 programmable profiles for shift keying
Sin(x)/(x) correction (inverse sinc filter)
Reference clock multiplier
Internal oscillator for a single crystal operation
Software and hardware controlled power-down
Integrated RAM
Phase modulation capability
Multichip synchronization
Easy interface to Blackfin SPORT
Interpolation factors from 4× to 252×
Interpolation DAC mode
Gain control DAC
Internal divider allows references up to 2 GHz
1.8 V and 3.3 V power supplies
100-lead TQFP_EP package

APPLICATIONS

HFC data, telephony, and video modems
Wireless base station transmissions
Broadband communications transmissions
Internet telephony

GENERAL DESCRIPTION

The AD9957 functions as a universal I/Q modulator and agile upconverter for communications systems where cost, size, power consumption, and dynamic performance are critical. The AD9957 integrates a high speed, direct digital synthesizer (DDS), a high performance, high speed, 14-bit digital-to-analog converter (DAC), clock multiplier circuitry, digital filters, and other DSP functions onto a single chip. It provides baseband upconversion for data transmission in a wired or wireless communications system.

The AD9957 is the third offering in a family of quadrature digital upconverters (QDUCs) that includes the AD9857 and AD9856. It offers performance gains in operating speed, power consumption, and spectral performance. Unlike its predecessors, it supports a 16-bit serial input mode for I/Q baseband data. The device can alternatively be programmed to operate either as a single tone, sinusoidal source or as an interpolating DAC.

The reference clock input circuitry includes a crystal oscillator, a high speed, divide-by-two input, and a low noise PLL for multiplication of the reference clock frequency.

The user interface to the control functions includes a serial port easily configured to interface to the SPORT of the Blackfin® DSP and profile pins to enable fast and easy shift keying of any signal parameter (phase, frequency, or amplitude).
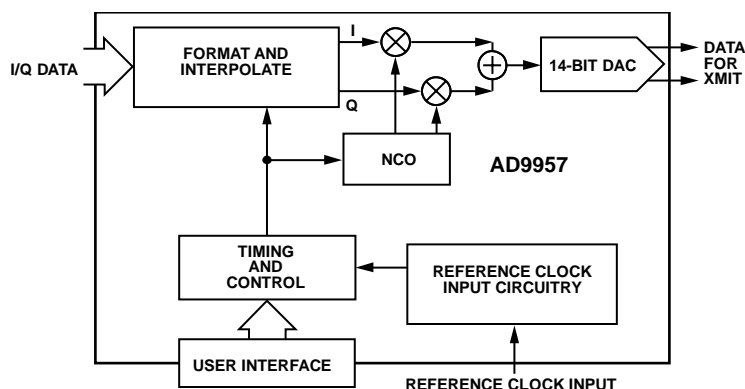
FUNCTIONAL BLOCK DIAGRAM

Figure 1.

Document Feedback

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COMPARABLE PARTS ⧉

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EVALUATION KITS ⧉

- AD9957 Evaluation Board

DOCUMENTATION ⧉

Application Notes

- AN-0996: The Advantages of Using a Quadrature Digital Upconverter (QDUC) in Point-to-Point Microwave Transmit Systems
- AN-837: DDS-Based Clock Jitter Performance vs. DAC Reconstruction Filter Performance
- AN-922: Digital Pulse-Shaping Filter Basics
- AN-924: Digital Quadrature Modulator Gain

Data Sheet

- AD9957: 1 GSPS Quadrature Digital Upconverter with 18-Bit I/Q Data Path and 14-Bit DAC Data Sheet

User Guides

- UG-208: Evaluation Board User Guide for AD9957

TOOLS AND SIMULATIONS ⧉

- AD9957 IBIS Model

REFERENCE MATERIALS ⧉

Technical Articles

- Improved DDS Devices Enable Advanced Comm Systems

DESIGN RESOURCES ⧉

- AD9957 Material Declaration
- PCN-PDN Information
- Quality And Reliability
- Symbols and Footprints

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ELECTRICAL SPECIFICATIONS

AVDD (1.8V) and DVDD (1.8V) = 1.8 V ± 5%, AVDD (3.3V) = 3.3 V ± 5%, DVDD_I/O (3.3V) = 3.3 V ± 5%, T = 25°C, R_{SET} = 10 kΩ, I_{OUT} = 20 mA, external reference clock frequency = 1000 MHz with REFCLK multiplier disabled, unless otherwise noted.

Table 1.

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
REF_CLK INPUT CHARACTERISTICS					
Frequency Range					
REFCLK Multiplier	Disabled	60		1000[1]	MHz
	Enabled	3.2		60	MHz
Maximum REFCLK Input Divider Frequency	Full temperature range	1500	1900		MHz
Minimum REFCLK Input Divider Frequency	Full temperature range		25	35	MHz
External Crystal			25		MHz
Input Capacitance			3		pF
Input Impedance (Differential)			2.8		kΩ
Input Impedance (Single-Ended)			1.4		kΩ
Duty Cycle	REFCLK multiplier disabled	45		55	%
	REFCLK multiplier enabled	40		60	%
REF_CLK Input Level	Single-ended	50		1000	mV p-p
	Differential	100		2000	mV p-p
REFCLK MULTIPLIER VCO GAIN CHARACTERISTICS					
VCO Gain (K_V) @ Center Frequency	VCO0 range setting		429		MHz/V
	VCO1 range setting		500		MHz/V
	VCO2 range setting		555		MHz/V
	VCO3 range setting		750		MHz/V
	VCO4 range setting		789		MHz/V
	VCO5 range setting[2]		850		MHz/V
REFCLK_OUT CHARACTERISTICS					
Maximum Capacitive Load			20		pF
Maximum Frequency			25		MHz
DAC OUTPUT CHARACTERISTICS					
Full-Scale Output Current		8.6	20	31.6	mA
Gain Error		−10		+10	%FS
Output Offset				2.3	µA
Differential Nonlinearity			0.8		LSB
Integral Nonlinearity			1.5		LSB
Output Capacitance			5		pF
Residual Phase Noise	@ 1 kHz offset, 20 MHz A_{OUT}				
REFCLK Multiplier	Disabled		−152		dBc/Hz
	Enabled @ 20×		−140		dBc/Hz
	Enabled @ 100×		−140		dBc/Hz
AC Voltage Compliance Range		−0.5		+0.5	V
SPURIOUS-FREE DYNAMIC RANGE (SFDR SINGLE TONE)					
f_{OUT} = 20.1 MHz			−70		dBc
f_{OUT} = 98.6 MHz			−69		dBc
f_{OUT} = 201.1 MHz			−61		dBc
f_{OUT} = 397.8 MHz			−54		dBc

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
NOISE SPECTRAL DENSITY (NSD)					
Single Tone					
f_{OUT} = 20.1 MHz			−167		dBm/Hz
f_{OUT} = 98.6 MHz			−162		dBm/Hz
f_{OUT} = 201.1 MHz			−157		dBm/Hz
f_{OUT} = 397.8 MHz			−151		dBm/Hz
TWO-TONE INTERMODULATION DISTORTION (IMD)	I/Q rate = 62.5 MSPS; 16× interpolation				
f_{OUT} = 25 MHz			−82		dBc
f_{OUT} = 50 MHz			−78		dBc
f_{OUT} = 100 MHz			−73		dBc
MODULATOR CHARACTERISTICS					
Input Data					
Error Vector Magnitude	2.5 Msymbols/s, QPSK, 4× oversampled		0.53		%
	270.8333 ksymbols/s, GMSK, 32× oversampled		0.77		%
	2.5 Msymbols/s, 256-QAM, 4× oversampled		0.35		%
WCDMA—FDD (TM1), 3.84 MHz Bandwidth, 5 MHz Channel Spacing					
Adjacent Channel Leakage Ratio (ACLR)	IF = 143.88 MHz		−78		dBc
Carrier Feedthrough			−78		dBc
SERIAL PORT TIMING CHARACTERISTICS					
Maximum SCLK Frequency			70		Mbps
Minimum SCLK Pulse Width	Low	4			ns
	High	4			ns
Maximum SCLK Rise/Fall Time			2		ns
Minimum Data Setup Time to SCLK		5			ns
Minimum Data Hold Time to SCLK		0			ns
Maximum Data Valid Time in Read Mode				11	ns
I/O_UPDATE/PROFILE<2:0>/RT TIMING CHARACTERISTICS					
Minimum Pulse Width	High	1			SYNC_CLK cycle
Minimum Setup Time to SYNC_CLK		1.75			ns
Minimum Hold Time to SYNC_CLK		0			ns
I/Q INPUT TIMING CHARACTERISTICS					
Maximum PDCLK Frequency			250		MHz
Minimum I/Q Data Setup Time to PDCLK		1.75			ns
Minimum I/Q Data Hold Time to PDCLK		0			ns
Minimum TxEnable Setup Time to PDCLK		1.75			ns
Minimum TxEnable Hold Time to PDCLK		0			ns
MISCELLANEOUS TIMING CHARACTERISTICS					
Wake-Up Time[3]			1		
Fast Recovery Mode			8		SYSCLK cycles[4]
Full Sleep Mode				150	μs
Minimum Reset Pulse Width High			5		SYSCLK cycles[4]
DATA LATENCY (PIPELINE DELAY)					
Data Latency Single Tone Mode					
Frequency, Phase-to-DAC Output			79		SYSCLK cycles[4]

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
CMOS LOGIC INPUTS					
Voltage					
Logic 1		2.0			V
Logic 0				0.8	V
Current					
Logic 1			90	150	µA
Logic 0			90	150	µA
Input Capacitance			2		pF
XTAL_SEL INPUT					
Logic 1 Voltage		1.25			V
Logic 0 Voltage				0.6	V
Input Capacitance			2		pF
CMOS LOGIC OUTPUTS	1 mA load				
Voltage					
Logic 1		2.8			V
Logic 0				0.4	V
POWER SUPPLY CURRENT					
DVDD_I/O (3.3V) Pin Current Consumption	QDUC mode		16		mA
DVDD (1.8V) Pin Current Consumption	QDUC mode		610		mA
AVDD (3.3V) Pin Current Consumption	QDUC mode		28		mA
AVDD (1.8V) Pin Current Consumption	QDUC mode		105		mA
POWER CONSUMPTION					
Single Tone Mode			800		mW
Continuous Modulation	8× interpolation		1400	1800	mW
Inverse Sinc Filter Power Consumption			150	200	mW
Full Sleep Mode			12	40	mW

[1] The system clock is limited to 750 MHz maximum in BFI mode.
[2] The gain value for VCO range Setting 5 is measured at 1000 MHz.
[3] Wake-up time refers to the recovery from analog power-down modes. The longest time required is for the Reference Clock Multiplier PLL to relock to the reference.
[4] SYSCLK cycle refers to the actual clock frequency used on-chip by the DDS. If the reference clock multiplier is used to multiply the external reference clock frequency, the SYSCLK frequency is the external frequency multiplied by the reference clock multiplication factor. If the reference clock multiplier and divider are not used, the SYSCLK frequency is the same as the external reference clock frequency.

ABSOLUTE MAXIMUM RATINGS

Table 2.

Parameter	Rating
AVDD (1.8V), DVDD (1.8V) Supplies	2 V
AVDD (3.3V), DVDD_I/O (3.3V) Supplies	4 V
Digital Input Voltage	−0.7 V to +4 V
XTAL_SEL	−0.7 V to +2.2 V
Digital Output Current	5 mA
Storage Temperature Range	−65°C to +150°C
Operating Temperature Range	−40°C to +85°C
θ$_{JA}$	22°C/W
θ$_{JC}$	2.8°C/W
Maximum Junction Temperature	150°C
Lead Temperature, Soldering (10 sec)	300°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.
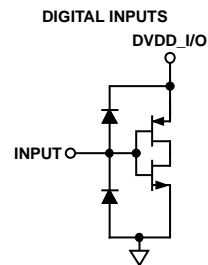
Figure 2. Equivalent Input Circuit
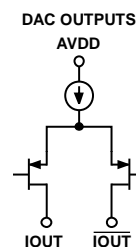
Figure 3. Equivalent Output Circuit

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

Figure 4. Pin Configuration
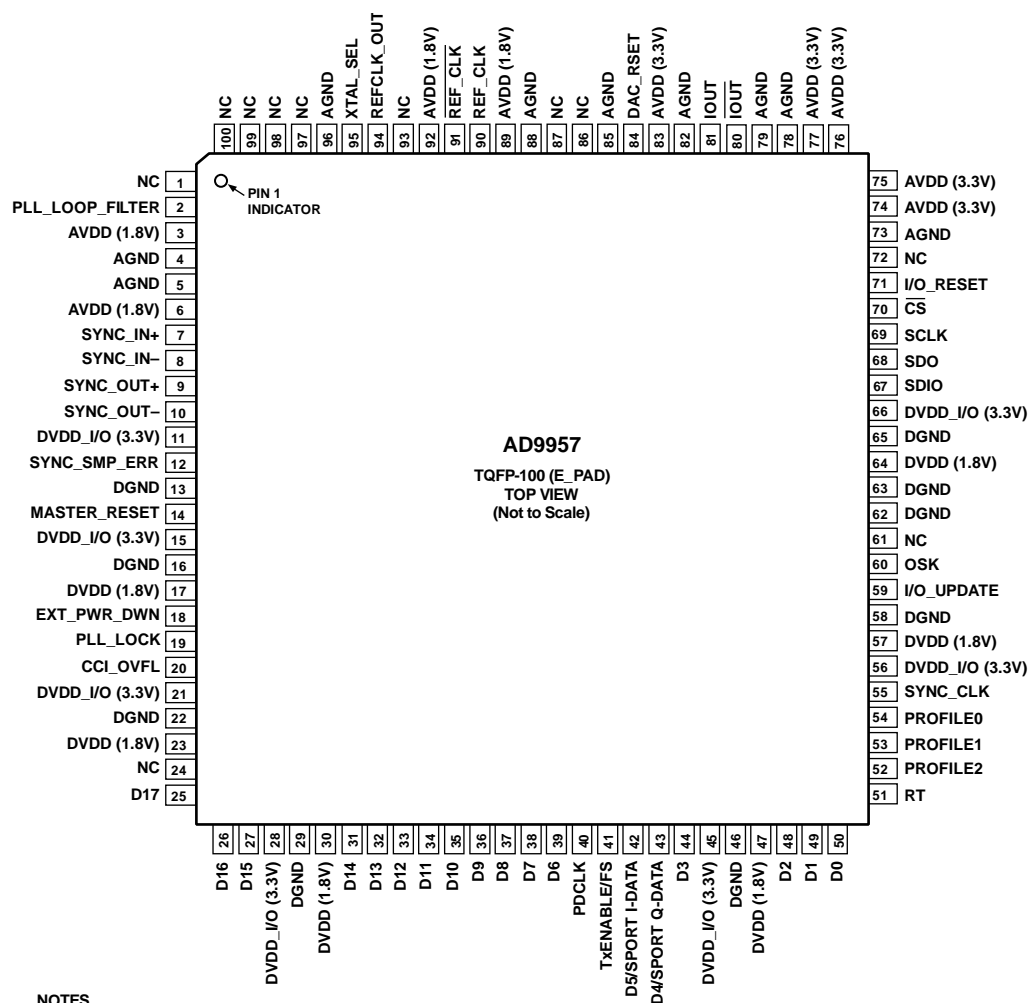
NOTES
1. NC = NO CONNECT.
2. EXPOSED PAD SHOULD BE SOLDERED TO GROUND.

Table 3. Pin Function Descriptions

Pin No.	Mnemonic	I/O[1]	Description
1, 24, 61, 72, 86, 87, 93, 97 to 100	NC		Not Connected. Allow the device pin to float.
2	PLL_LOOP_FILTER	I	PLL Loop Filter Compensation. See External PLL Loop Filter Components section.
3, 6, 89, 92	AVDD (1.8V)	I	Analog Core VDD. 1.8 V analog supplies.
74 to 77, 83	AVDD (3.3V)	I	Analog DAC VDD. 3.3 V analog supplies.
17, 23, 30, 47, 57, 64	DVDD (1.8V)	I	Digital Core VDD. 1.8 V digital supplies.
11, 15, 21, 28, 45, 56, 66	DVDD_I/O (3.3V)	I	Digital Input/Output VDD. 3.3 V digital supplies.
4, 5, 73, 78, 79, 82, 85, 88, 96	AGND	I	Analog Ground.
13, 16, 22, 29, 46, 58, 62, 63, 65	DGND	I	Digital Ground.
7	SYNC_IN+	I	Synchronization Signal, Digital Input (Rising Edge Active). Synchronization signal from external master to synchronize internal subclocks. See the Synchronization of Multiple Devices section.
8	SYNC_IN−	I	Synchronization Signal, Digital Input (Falling Edge Active). Synchronization signal from external master to synchronize internal subclocks. See the Synchronization of Multiple Devices section.
9	SYNC_OUT+	O	Synchronization Signal, Digital Output (Rising Edge Active). Synchronization signal from internal device subclocks to synchronize external slave devices. See the Synchronization of Multiple Devices section.
10	SYNC_OUT−	O	Synchronization Signal, Digital Output (Falling Edge Active). Synchronization signal from internal device subclocks to synchronize external slave devices. See the Synchronization of Multiple Devices section.
12	SYNC_SMP_ERR	O	Synchronization Sample Error, Digital Output (Active High). A high on this pin indicates that the AD9957 did not receive a valid sync signal on SYNC_IN+/SYNC_IN−. See the Synchronization of Multiple Devices section.
14	MASTER_RESET	I	Master Reset, Digital Input (Active High). This pin clears all memory elements and sets registers to default values.
18	EXT_PWR_DWN	I	External Power-Down, Digital Input (Active High). A high level on this pin initiates the currently programmed power-down mode. See the Power-Down Control section for further details. If unused, tie to ground.
19	PLL_LOCK	O	PLL Lock, Digital Output (Active High). A high on this pin indicates that the clock multiplier PLL has acquired lock to the reference clock input.
20	CCI_OVFL	O	CCI Overflow Digital Output, Active High. A high on this pin indicates a CCI filter overflow. This pin remains high until the CCI overflow condition is cleared.
25 to 27, 31 to 39, 42 to 44, 48 to 50	D<17:0>	I/O	Parallel Data Input Bus (Active High). These pins provide the interleaved, 18-bit, digital, I and Q vectors for the modulator to upconvert. Also used for a GPIO port in Blackfin interface mode.
42	SPORT I-DATA	I	I-Data Serial Input. In Blackfin interface mode, this pin serves as the I-data serial input.
43	SPORT Q-DATA	I	Q-Data Serial Input. In Blackfin interface mode, this pin serves as the Q-data serial input.
40	PDCLK	O	Parallel Data Clock, Digital Output (Clock). See the Signal Processing section for details.
41	TxENABLE/FS	I	Transmit Enable, Digital Input (Active High). See the Signal Processing section for details. In Blackfin interface mode, this pin serves as the FS input to receive the RFS output signal from the Blackfin.
51	RT	I	RAM Trigger, Digital Input (Active High). This pin provides control for the RAM amplitude scaling function. When this function is engaged, a high sweeps the amplitude from the beginning RAM address to the end. A low sweeps the amplitude from the end RAM address to the beginning. If unused, connect to ground or supply.
52 to 54	PROFILE<2:0>	I	Profile Select Pins, Digital Inputs (Active High). These pins select one of eight phase/frequency profiles for the DDS core (single tone or carrier tone). Changing the state of one of these pins transfers the current contents of all I/O buffers to the corresponding registers. Set up state changes to the SYNC_CLK pin.
55	SYNC_CLK	O	Output System Clock/4, Digital Output (Clock). Set up the I/O_UPDATE and PROFILE<2:0> pins to the rising edge of this signal.

Pin No.	Mnemonic	I/O[1]	Description
59	I/O_UPDATE	I/O	Input/Output Update; Digital Input Or Output (Active High), Depending on the Internal I/O Update Active Bit. A high on this pin indicates a transfer of the contents of the I/O buffers to the corresponding internal registers.
60	OSK	I	Output Shift Keying, Digital Input (Active High). When using OSK (manual or automatic), this pin controls the OSK function. See the Output Shift Keying (OSK) section of the data sheet for details. When not using OSK, tie this pin high.
67	SDIO	I/O	Serial Data Input/Output, Digital Input/Output (Active High). This pin can be either unidirectional or bidirectional (default), depending on configuration settings. In bidirectional serial port mode, this pin acts as the serial data input and output. In unidirectional, it is an input only.
68	SDO	O	Serial Data Output, Digital Output (Active High). This pin is only active in unidirectional serial data mode. In this mode, it functions as the output. In bidirectional mode, this pin is not operational and must be left floating.
69	SCLK	I	Serial Data Clock. Digital clock (rising edge on write, falling edge on read). This pin provides the serial data clock for the control data path. Write operations to the AD9957 use the rising edge. Readback operations from the AD9957 use the falling edge.
70	$\overline{CS}$	I	Chip Select, Digital Input (Active Low). Bringing this pin low enables the AD9957 to detect serial clock rising/falling edges. Bringing this pin high causes the AD9957 to ignore input on the serial data pins.
71	I/O_RESET	I	Input/Output Reset. Digital input (active high). This pin can be used when a serial I/O communication cycle fails (see the I/O_RESET—Input/Output Reset section for details). When not used, connect this pin to ground.
80	$\overline{IOUT}$	O	Open-Source DAC Complementary Output Source. Analog output, current mode. Connect through 50 Ω to AGND.
81	IOUT	O	Open-Source DAC Output Source. Analog output, current mode. Connect through 50 Ω to AGND.
84	DAC_RSET	O	Analog Reference Pin. This pin programs the DAC output full-scale reference current. Attach a 10 kΩ resistor to AGND.
90	REF_CLK	I	Reference Clock Input. Analog input. See the REFCLK Overview section for more details.
91	$\overline{REF\_CLK}$	I	Complementary Reference Clock Input. Analog input. See the REFCLK Overview section for more details.
94	REFCLK_OUT	O	Reference Clock Output. Analog output. See the REFCLK Overview section for more details.
95	XTAL_SEL	I	Crystal Select (1.8 V Logic). Analog input (active high). Driving the XTAL_SEL pin high enables the internal oscillator to be used with a crystal resonator. If unused, connect it to AGND.
(EPAD)	Exposed Pad (EPAD)		The EPAD should be soldered to ground.

[1] I is input, O is output.

TYPICAL PERFORMANCE CHARACTERISTICS
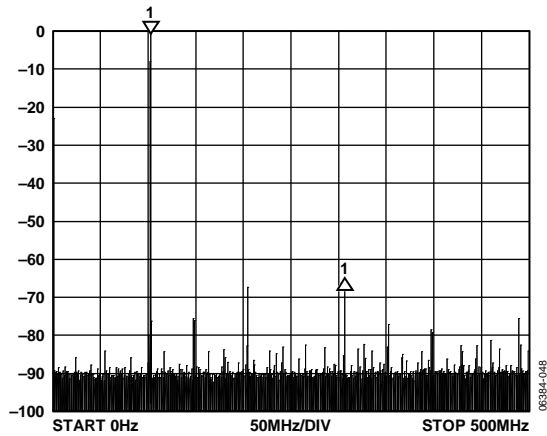
Figure 5. 15.625 kHz Quadrature Tone, Carrier = 102 MHz, CCI = 16, f_S = 1 GHz
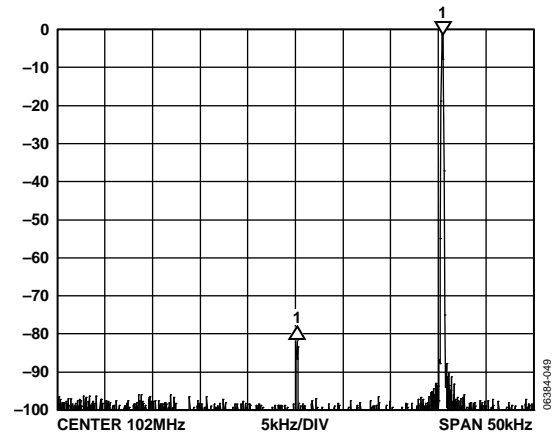
Figure 8. Narrow-Band View of Figure 5 (with Carrier and Lower Sideband Suppression)
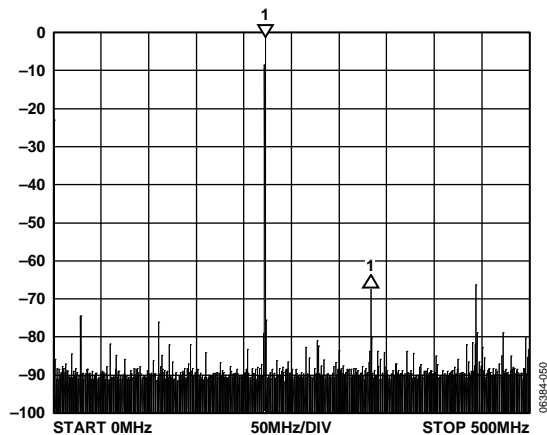
Figure 6. 15.625 kHz Quadrature Tone, Carrier = 222 MHz, CCI = 16, f_S = 1 GHz
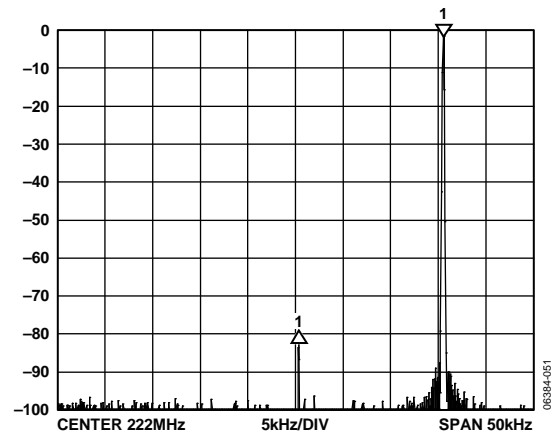
Figure 9. Narrow-Band View of Figure 6 (with Carrier And Lower Sideband Suppression)
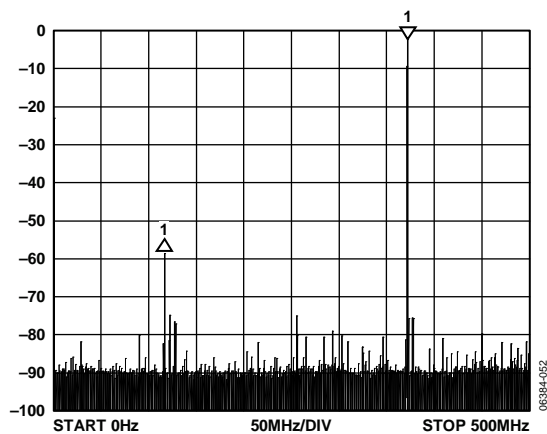
Figure 7. 15.625 kHz Quadrature Tone, Carrier = 372 MHz, CCI = 16, f_S = 1 GHz
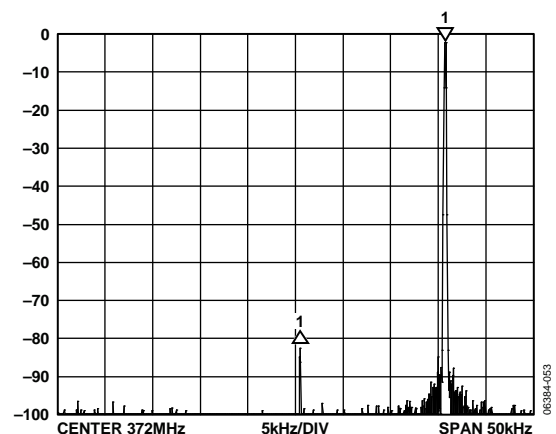
Figure 10. Narrow-Band View of Figure 7 (with Carrier and Lower Sideband Suppression)
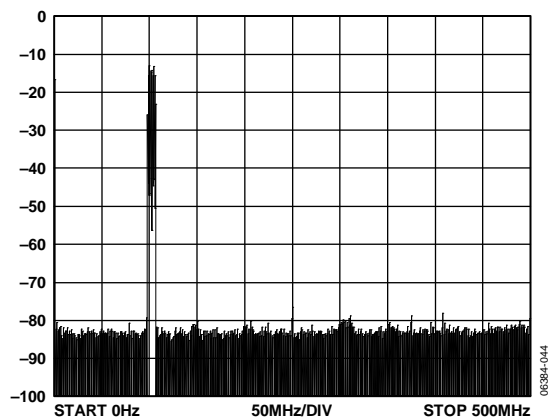
Figure 11. QPSK, 7.8125 Msymbols/s, 4x Oversampled Raised Cosine,
α = 0.25, CCI = 8, Carrier = 102 MHz, f_S = 1 GHz
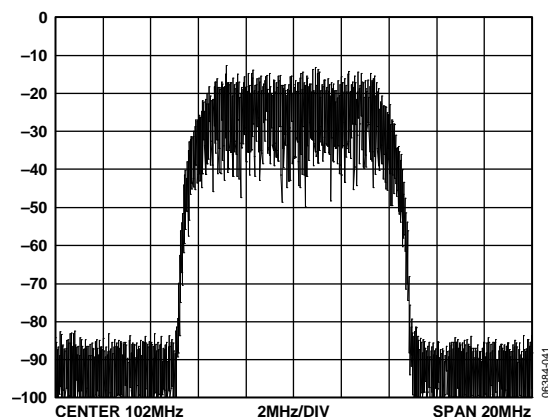
Figure 14. Narrow-Band View of Figure 11
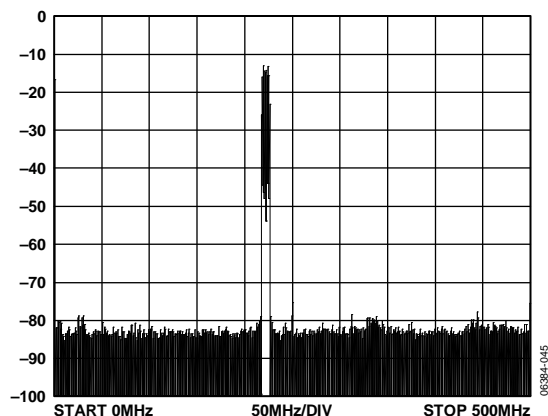
Figure 12. QPSK, 7.8125 Msymbols/s, 4x Oversampled Raised Cosine,
α = 0.25, CCI = 8, Carrier = 222 MHz, f_S = 1 GHz
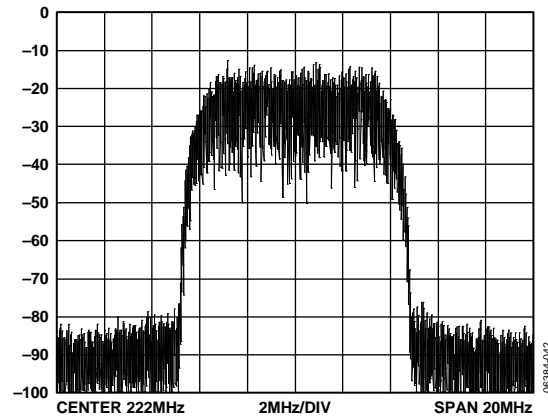
Figure 15. Narrow-Band View of Figure 12
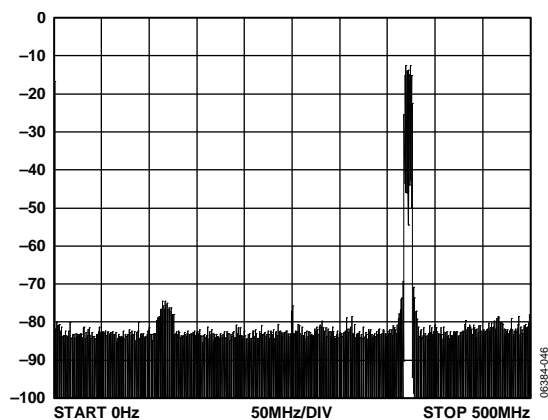
Figure 13. QPSK, 7.8125 Msymbols/s, 4x Oversampled Raised Cosine,
α = 0.25, CCI = 8, Carrier = 372 MHz, f_S = 1 GHz
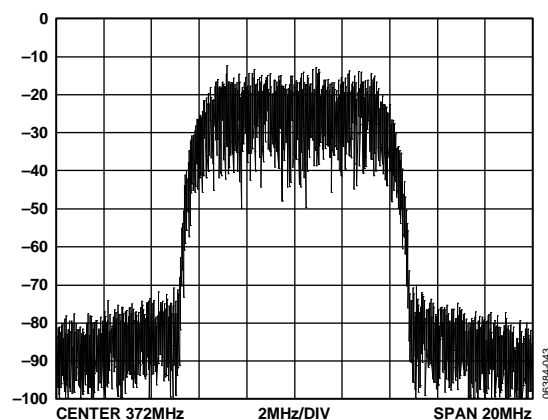
Figure 16. Narrow-Band View of Figure 13
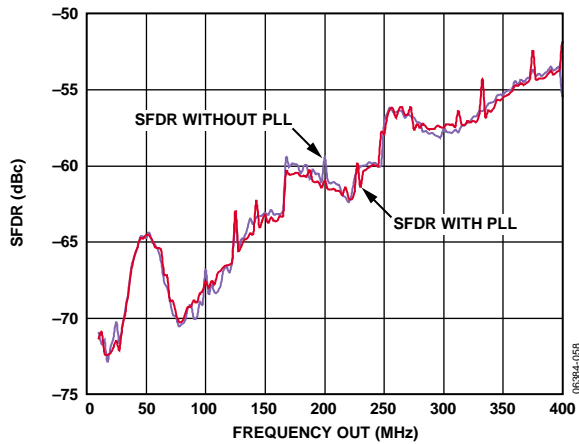
Figure 17. Wideband SFDR vs. Output Frequency in Single Tone Mode,
PLL with REFCLK = 15.625 MHz × 64
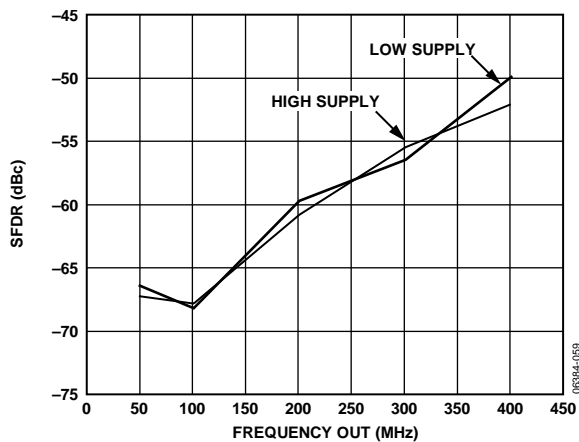
Figure 18. SFDR vs. Output Frequency and Supply (±5%) in Single Tone
Mode, REFCLK = 1 GHz
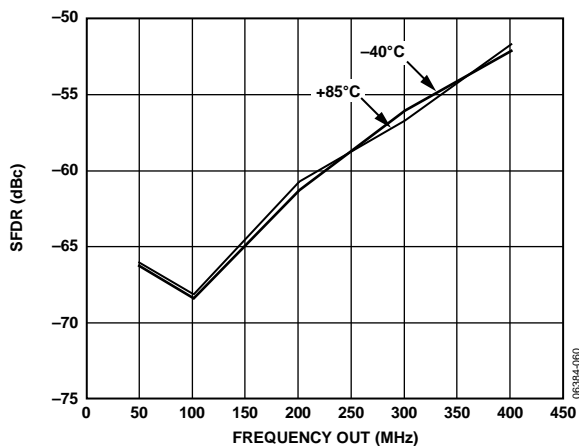
Figure 19. SFDR vs. Frequency and Temperature in Single Tone Mode,
REFCLK = 1 GHz
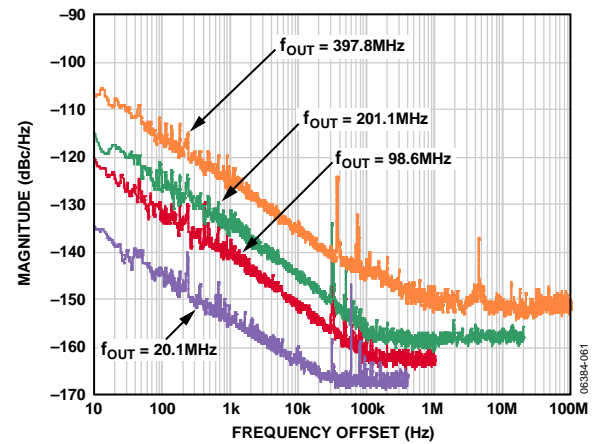
Figure 20. Residual Phase Noise, System Clock = 1 GHz
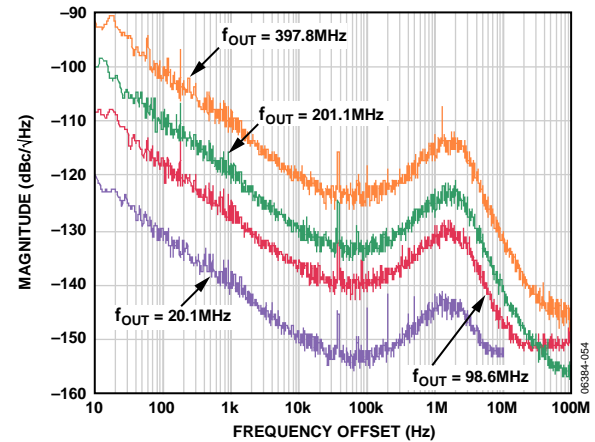
Figure 21. Residual Phase Noise Using the REFCLK Multiplier,
REFCLK = 50 MHz with 20x Multiplication, System Clock = 1 GHz
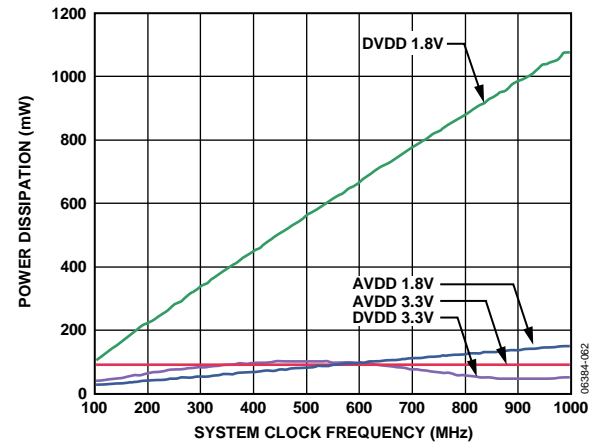
Figure 22. Power Dissipation vs. System Clock (PLL Disabled)
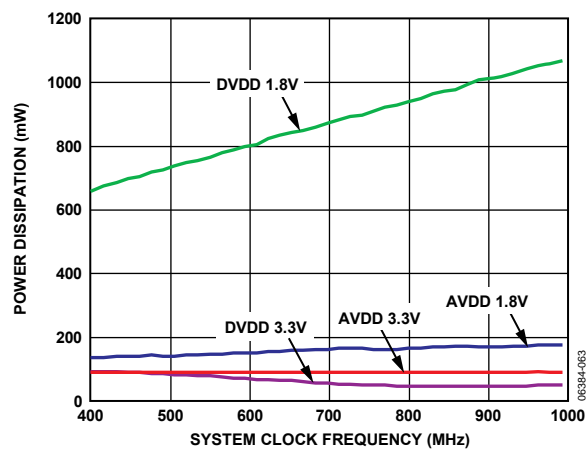
Figure 23. Power Dissipation vs. System Clock (PLL Enabled)

CENTER 143.86MHz   2.55MHz/DIV   SPAN 25.5MHz
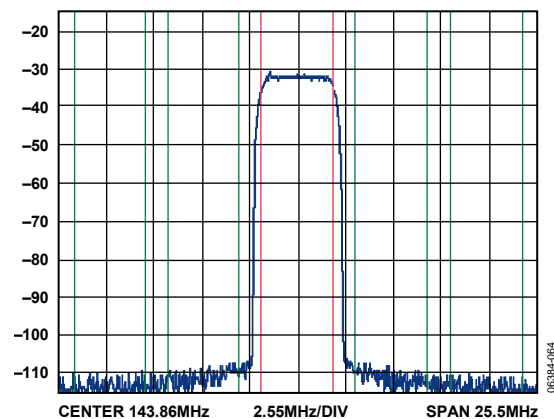
Tx CHANNEL
BANDWIDTH: 3.84MHz   **W-CDMA SGFF FWD**
                             POWER: −11.88dBm

ADJACENT CHANNEL
BANDWIDTH: 3.84MHz   **LOWER: −78.27dB**
SPACING: 3MHz   **UPPER: −78.50dB**

ADJACENT CHANNEL
BANDWIDTH: 3.84MHz   **LOWER: −81.42dB**
SPACING: 10MHz   **UPPER: −81.87dB**

Figure 24. Typical ACLR for Wideband CDMA

MODES OF OPERATION

OVERVIEW

The AD9957 has three basic operating modes.

- Quadrature modulation (QDUC) mode (default)
- Interpolating DAC mode
- Single tone mode

The active mode is selected via the operating mode bits in Control Function Register 1 (CFR1). Single tone mode allows the device to operate as a sinusoidal generator with the DDS driving the DAC directly.

Interpolating DAC mode bypasses the DDS, allowing the user to deliver baseband data to the device at a sample rate lower than that of the DAC. An internal chain of rate interpolation filters the user data and upsamples to the DAC sample rate. Combined, the filters provide for programmable rate interpolation while suppressing spectral images and retaining the original baseband spectrum.

QDUC mode employs both the DDS and the rate interpolation filters. In this case, two parallel banks of rate interpolation filters allow baseband processing of in-phase and quadrature (I/Q) signals with the DDS providing the carrier signal to be modulated by the baseband signals. A detailed block diagram of the AD9957 is shown in Figure 25.

The inverse sinc filter is available in all three modes.
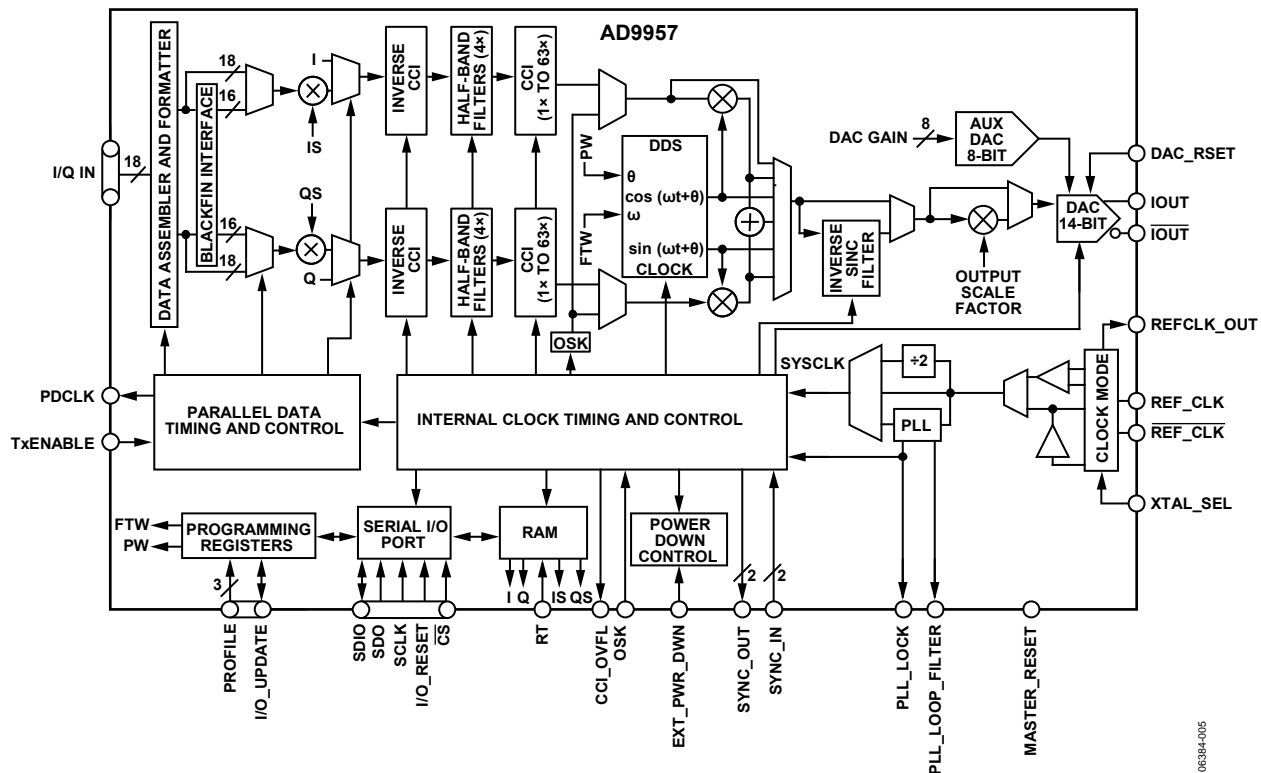
Figure 25. Detailed Block Diagram

QUADRATURE MODULATION MODE

A block diagram of the AD9957 operating in QDUC mode is shown in Figure 26; grayed items are inactive. The parallel input accepts 18-bit I- and Q-words in time-interleaved fashion. That is, an 18-bit I-word is followed by an 18-bit Q-word, then the next 18-bit I-word, and so on. One 18-bit I-word and one 18-bit Q-word together comprise one internal sample. The data assembler and formatter de-interleave the I- and Q-words so that each sample propagates along the internal data pathway in parallel fashion. Both I and Q data paths are active; the parallel data clock (PDCLK) serves to synchronize the input of I/Q data to the AD9957.

The PROFILE and I/O_UPDATE pins are also synchronous to the PDCLK.

The DDS core provides a quadrature (sine and cosine) local oscillator signal to the quadrature modulator, where the interpolated I and Q samples are multiplied by the respective phase of the carrier and summed together, producing a quadrature modulated data stream. This data stream is routed through the inverse sinc filter (optionally), and the output scaling multiplier. Then it is applied to the 14-bit DAC to produce the quadrature modulated analog output signal.
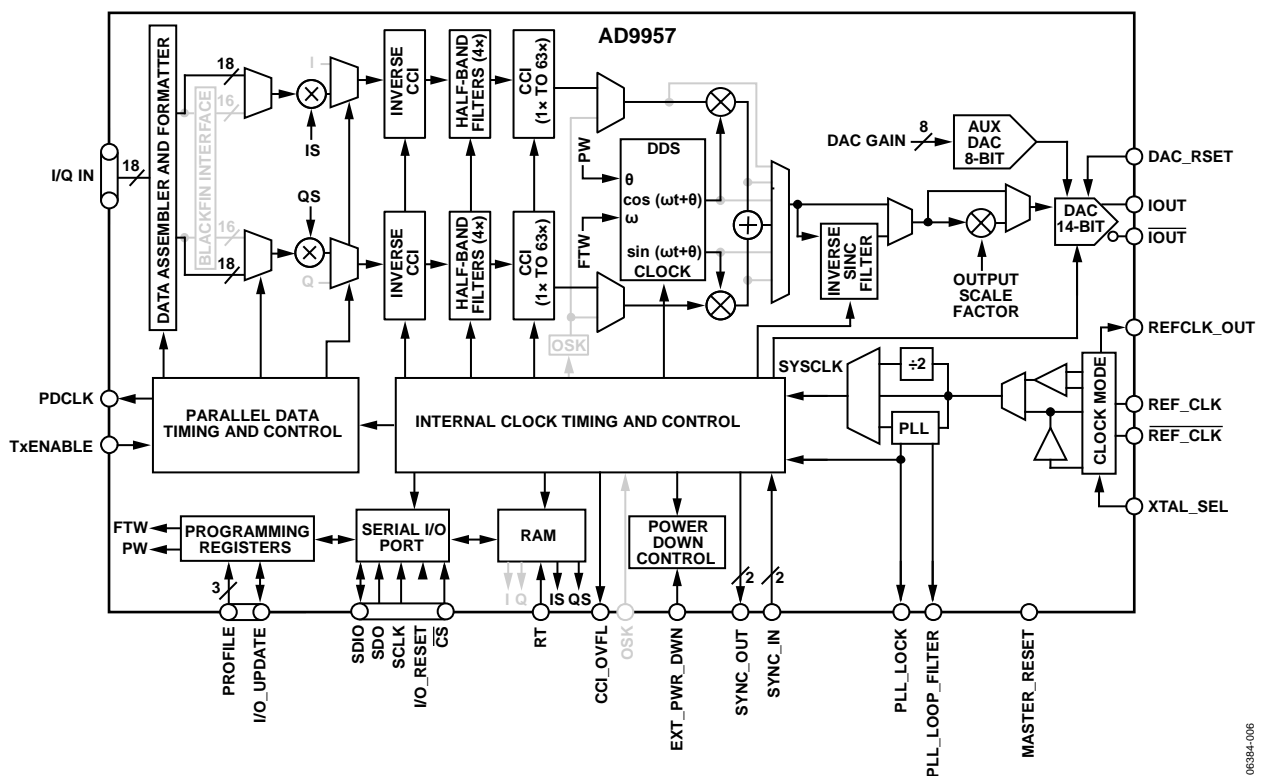
Figure 26. Quadrature Modulation Mode

BLACKFIN INTERFACE (BFI) MODE

A subset of the QDUC mode is the Blackfin interface (BFI) mode, shown in Figure 27; grayed items are inactive. In this mode, a separate I and Q serial bit stream is applied to the baseband data port instead of parallel data-words. The two serial inputs provide for 16-bit I- and Q-words (unlike the 18-bit words in normal QDUC mode). The serial bit streams are delivered to the Blackfin interface. The Blackfin interface converts the 16-bit serial data into 16-bit parallel data to propagate down the signal processing chain.

The Blackfin interface includes an additional pair of half-band filters in both I and Q signal paths (not shown explicitly in the diagram). The two half-band filters increase the interpolation of the baseband data by a factor of four, relative to the normal QDUC mode.

The synchronization of the serial data occurs through the PDCLK signal. In BFI mode, the PDCLK signal is effectively the bit clock for the serial data.

Note that the system clock is limited to 750 MHz in BFI mode.
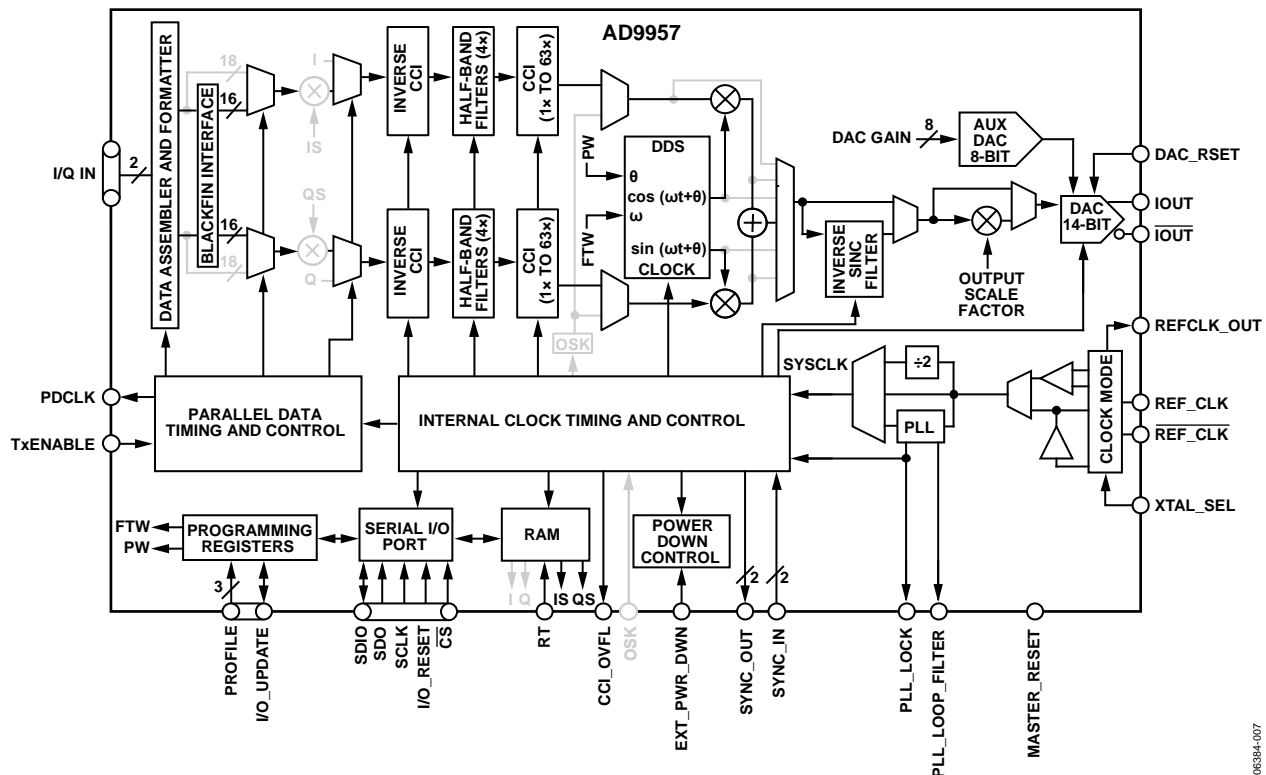
Figure 27. Quadrature Modulation Mode, Blackfin Interface

INTERPOLATING DAC MODE

A block diagram of the AD9957 operating in interpolating DAC mode is shown in Figure 28; grayed items are inactive. In this mode, the Q data path, DDS, and modulator are all disabled; only the I data path is active.

As in quadrature modulation mode, the PDCLK pin functions as a clock, synchronizing the input of data to the AD9957.

No modulation takes place in the interpolating DAC mode; therefore, the spectrum of the data supplied at the parallel port remains at baseband. However, a sample rate conversion takes place based on the programmed interpolation rate. The interpolation hardware processes the signal, effectively performing an oversample with a zero-stuffing operation. The original input spectrum remains intact and the images that otherwise would occur from the sample rate conversion process are suppressed by the interpolation signal chain.
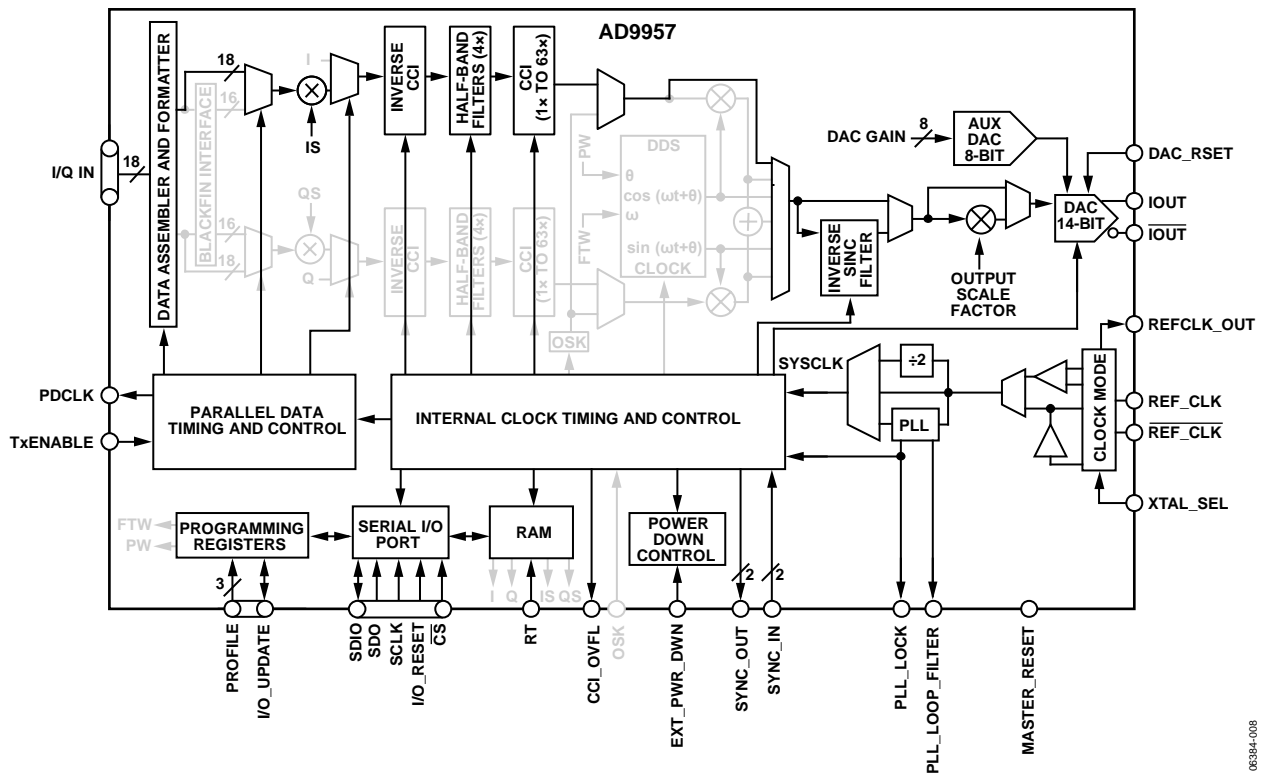
Figure 28. Interpolating DAC Mode

SINGLE TONE MODE

A block diagram of the AD9957 operating in single tone mode is shown in Figure 29; grayed items are inactive. In this mode, both I and Q data paths are disabled from the 18-bit parallel data port up to, and including, the modulator. The internal DDS core produces a single frequency signal based on the programmed tuning word. The user may select either the

cosine or sine output of the DDS. The sinusoid at the DDS output can be scaled using a 14-bit amplitude scale factor (ASF) and optionally routed through the inverse sinc filter.

Single tone mode offers the output shift keying (OSK) function. It provides the ability to ramp the amplitude scale factor between zero and an arbitrary preset value over a programmable time interval.
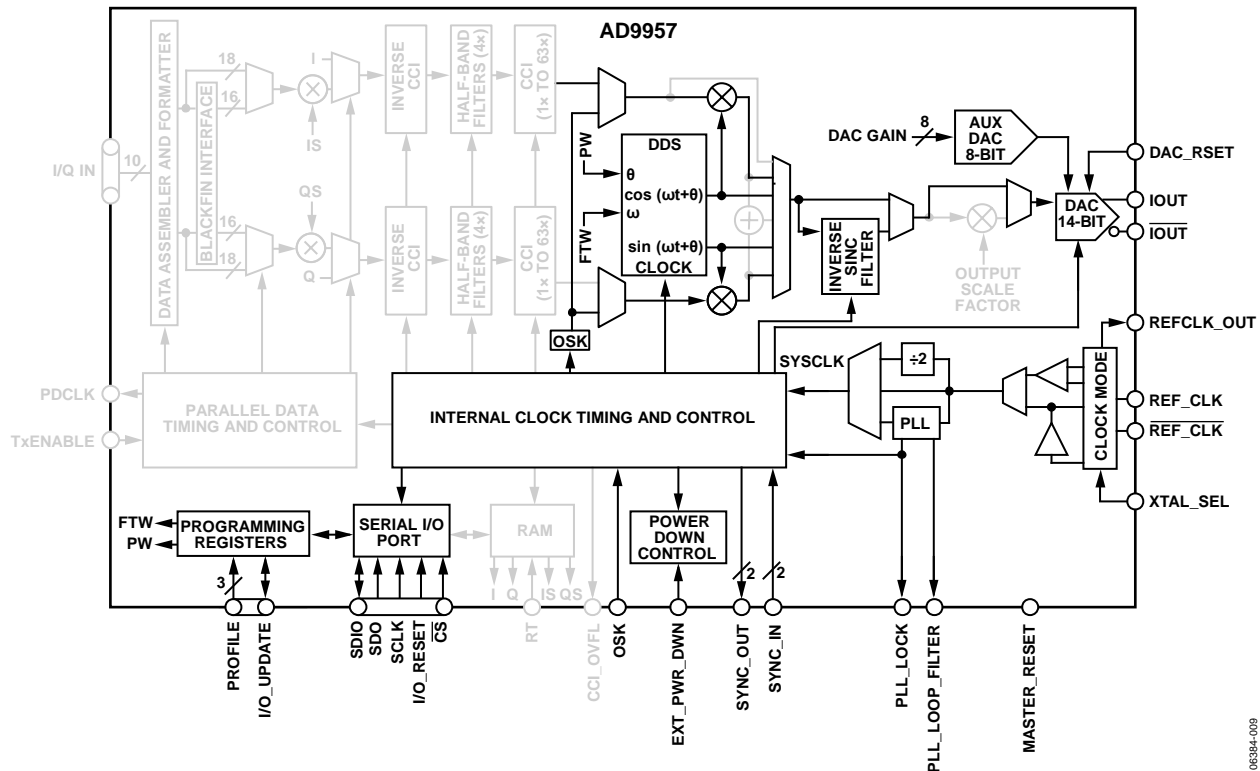
Figure 29. Single Tone Mode

SIGNAL PROCESSING

For a better understanding of the operation of the AD9957, it is helpful to follow the signal path in quadrature modulation mode from the parallel data port to the output of the DAC, examining the function of each block (see Figure 26).

The internal system clock (SYSCLK) signal that generates from the timing source provided to the REF_CLK pins provides all timing within the AD9957.

PARALLEL DATA CLOCK (PDCLK)

The AD9957 generates a signal on the PDCLK pin, which is a clock signal that runs at the sample rate of the parallel data port. PDCLK serves as a data clock for the parallel port in QDUC and interpolating DAC modes; in BFI mode, it is a bit clock. Normally, the device uses the rising edges on PDCLK to latch the user-supplied data into the data port. Alternatively, the PDCLK Invert bit selects the falling edges as the active edges. Furthermore, the PDCLK enable bit is used to switch off the PDCLK signal. Even when the output signal is turned off via the PDCLK enable bit, PDCLK continues to operate internally. The device uses PDCLK internally to capture parallel data. Note that PDCLK is Logic 0 when disabled.

In QDUC mode, the AD9957 expects alternating I- and Q-data-words at the parallel port (see Figure 31). Each active edge of PDCLK captures one 18-bit word; therefore, there are two PDCLK cycles per I/Q pair. In BFI mode, the AD9957 expects two serial bit streams, each segmented into 16-bit words with PDCLK indicating each new bit. In either case, the output clock rate is f_{PDCLK} as explained in the Input Data Assembler section.

In QDUC applications that require a consistent timing relationship between the internal SYSCLK signal and the PDCLK signal, the PDCLK rate control bit is used to slightly alter the operation of PDCLK. When this bit is set, the PDCLK rate is reduced by a factor of two. This causes rising edges on PDCLK to latch incoming I-words and falling edges to latch incoming Q-words. Again, the edge polarity assignment is reversible via the PDCLK Invert bit.

TRANSMIT ENABLE PIN (TxENABLE)

The AD9957 accepts a user-generated signal applied to the TxENABLE pin that gates the user supplied data. Polarity of the TxENABLE pin is set using the TxENABLE invert bit (see the Register Map section for details). When TxENABLE is true, the device latches data into the device on the expected edge of PDCLK (based on the PDCLK invert bit). When TxENABLE is false, the device ignores the data supplied to the port, even though the PDCLK may continue to operate. Furthermore, when the TxENABLE pin is held false, then the device either forces the 18-bit data-words to Logic 0s, or it retains the last value present on the data port prior to TxENABLE switching to the false state (see the data assembler hold last value bit in the Register Map section).

Alternatively, rather than operating the TxENABLE pin as a gate for framing bursts of data, it can be driven with a clock signal operating at the parallel port data rate. When driven by a clock signal, the transition from the false to true state must meet the required setup and hold times on each cycle to ensure proper operation.

In QDUC mode, on the false-to-true edge of TxENABLE, the device is ready to receive the first I-word. The first I-word is latched into the device coincident with the active edge of PDCLK. The next active edge of PDCLK latches in a Q-word, and so on, until TxENABLE is returned to a static false state. The user may reverse the ordering of the I- and Q-words via the Q-First Data Pairing bit. Furthermore, the user must ensure that an even number of data words are delivered to the device as it must capture both an I- and a Q-word before the data is processed along the signal chain.

In interpolating DAC mode, TxENABLE operation is similar to QDUC mode, but without the need for I/Q data pairing; the even-number-of-PDCLK-cycles rule does not apply.

In BFI mode, operation of the TxENABLE pin is similar except that instead of the false-to-true edge marking the first I-word, it marks the first I and Q bits in a serial frame. The user must ensure that all 16-bits of a serial frame are delivered because the device must capture a full 16-bit I- and Q-word before the data is processed along the signal chain.

The timing relationships between TxENABLE, PDCLK, and DATA are shown in Figure 30, Figure 31, and Figure 32.
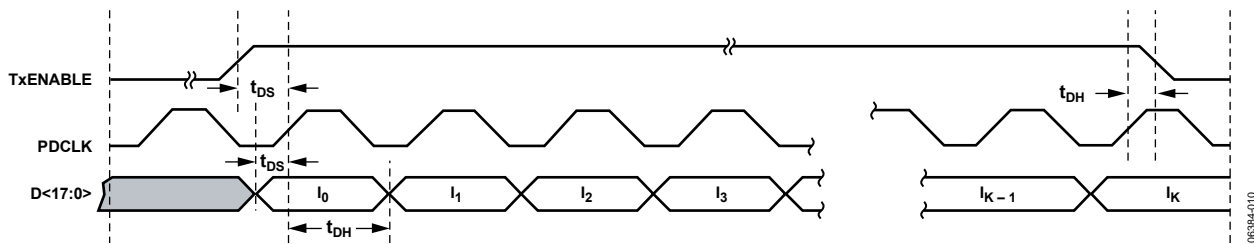
Figure 30. 18-Bit Parallel Port Timing Diagram—Interpolating DAC Mode
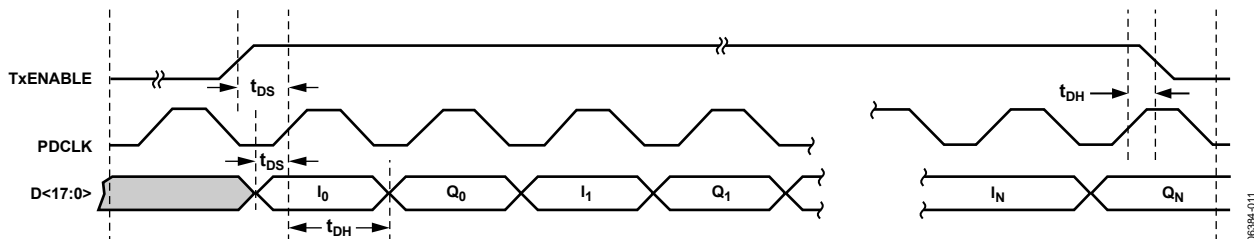
Figure 31. 18-Bit Parallel Port Timing Diagram—Quadrature Modulation Mode
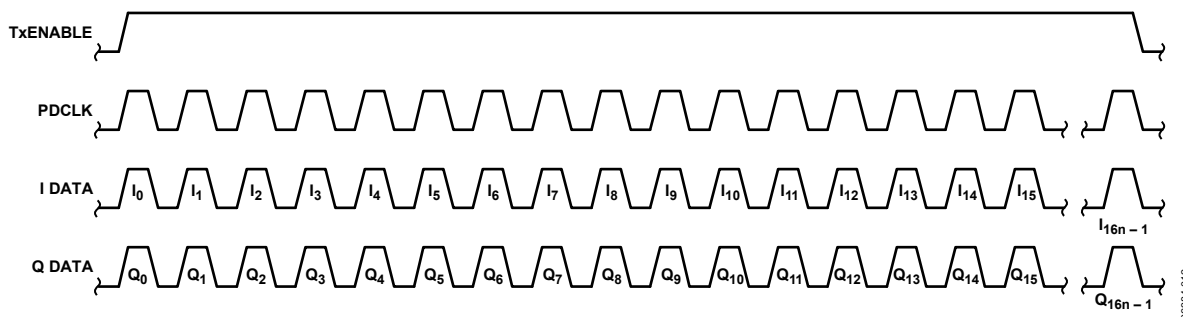
Figure 32. Dual Serial I/Q Bit Stream Timing Diagram, BFI Mode

INPUT DATA ASSEMBLER

The input to the AD9957 is an 18-bit parallel data port in QDUC mode or interpolating DAC mode. In BFI mode, it operates as a dual serial data port.

In QDUC mode, it is assumed that two consecutive 18-bit words represent the real (I) and imaginary (Q) parts of a complex number of the form, I + jQ. The 18-bit words are supplied to the input of the AD9957 at a rate of

$$f_{PDCLK} = \frac{f_{SYSCLK}}{2R} \text{ for QDUC mode}$$

where:
f_{SYSCLK} (for all of the PDCLK equations in this section) is the sample rate of the DAC.
R (for all of the PDCLK equations in this section) is the interpolation factor of the programmable interpolation filter.

When the PDCLK rate control bit is active in QDUC mode, however, the frequency of PDCLK becomes

$$f_{PDCLK} = \frac{f_{SYSCLK}}{4R} \text{ with PDCLK rate control active}$$

In the interpolating DAC mode, the rate of PDCLK is the same as QDUC mode with the PDCLK rate control bit active, that is,

$$f_{PDCLK} = \frac{f_{SYSCLK}}{4R} \text{ for interpolating DAC mode}$$

In BFI mode, the 18-bit parallel input converts to a dual serial input that is, one pin is assigned as the serial input for the I-words and one pin is assigned as the serial input for the Q-words. The other 16 pins are not used. Furthermore, each I- and Q-word has a 16-bit resolution. f_{PDCLK} is the bit rate of the I- and Q-data streams and is given by

$$f_{PDCLK} = \frac{f_{SYSCLK}}{R} \text{ for BFI mode}$$

Encoding and pulse shaping of symbols must be implemented before the data is presented to the input of the AD9957. Data delivered to the input of the AD9957 may be formatted as either twos complement or offset binary (see the Data Format bit in Table 13). In BFI mode, the bit sequence order can be set to either MSB-first or LSB-first (via the Blackfin Bit Order bit).

INVERSE CCI FILTER

The inverse cascaded comb integrator (CCI) filter predistorts the data, compensating for the slight attenuation gradient imposed by the CCI filter (see the Programmable Interpolating Filter section). Data entering the first half-band filter occupies a maximum bandwidth of ½ f_{IQ} as defined by Nyquist (where f_{IQ} is the sample rate at the input of the first half-band filter); see Figure 33.

If the CCI filter is used, the in-band attenuation gradient can pose a problem for applications requiring an extremely flat pass band. For example, if the spectrum of the data supplied to the AD9957 occupies a significant portion of the ½ f_{DATA} region, the higher frequencies of the data spectrum are slightly more attenuated than the lower frequencies (the worst-case overall droop from f = 0 to ½ f_{DATA} is <0.8 dB). The inverse CCI filter has a response characteristic that is the inverse of the CCI filter response over the ½ f_{IQ} region.
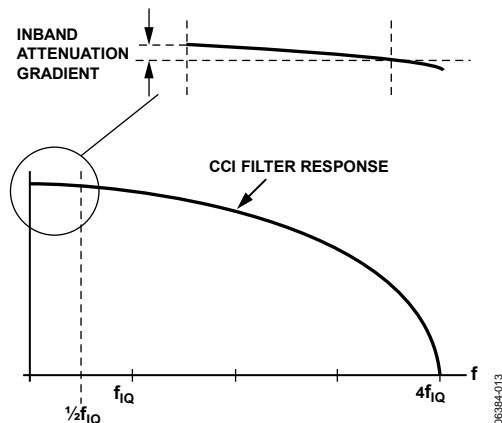
Figure 33. CCI Filter Response

The product of the two responses yields an extremely flat pass band (±0.05 dB over the baseband Nyquist bandwidth) eliminating the in-band attenuation gradient introduced by the CCI filter. The cost is a slight attenuation of the input signal (approximately 0.5 dB for a CCI interpolation rate of 2, and 0.8 dB for higher interpolation rates).

The inverse CCI filter can be bypassed using the appropriate bit in the register map; it is automatically bypassed if the CCI interpolation rate is 1×. When bypassed, power to the stage turns off to reduce power consumption.

FIXED INTERPOLATOR (4×)

This block is a fixed 4× rate interpolator, implemented as a cascade of two half-band filters. Together, the sampling rate of these two filters increases by a factor of four while preserving the spectrum of the baseband signal applied at the input. Both are linear phase filters; virtually no phase distortion is introduced within their pass bands. Their combined insertion loss is 0.01 dB, preserving the relative amplitude of the input signal.

The filters are designed to deliver a composite performance that yields a usable pass band of 40% of the input sample rate. Within that pass band, ripple does not exceed 0.002 dB peak-to-peak. The stop band extends from 60% to 340% of the input sample rate and offers a minimum of 85 dB attenuation. Figure 34 and Figure 35 show the composite response of the two half-band filters.
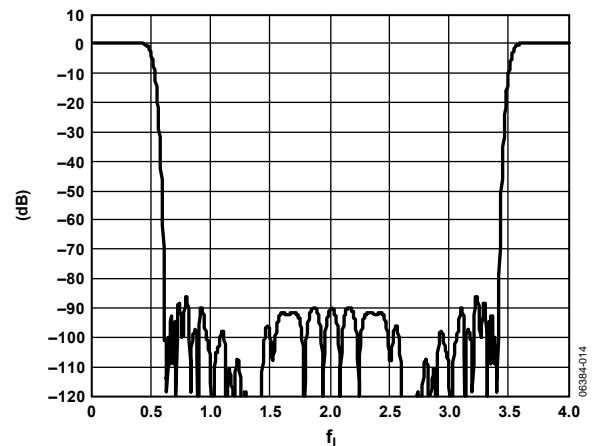
Figure 34. Half-Band 1 and Half-Band 2 Composite Response (Frequency Scaled to Input Sample Rate of Half-Band 1)
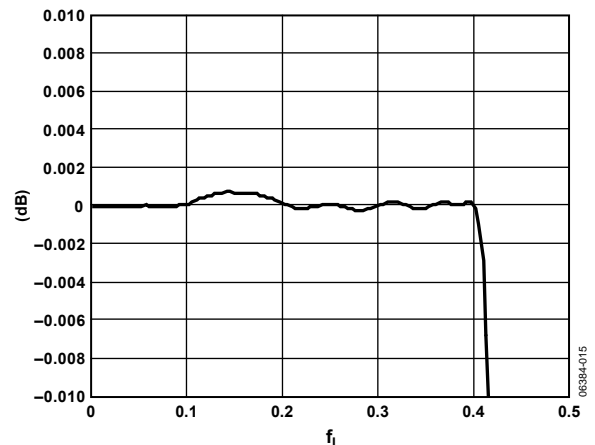
Figure 35. Composite Pass-Band Detail (Frequency Scaled to Input Sample Rate of Half-Band 1)

In BFI mode, there are two additional half-band filters resident, yielding a total fixed interpolation factor of 16×. The extra BFI filters use the same filter tap coefficient values as the QDUC half-band filters, but their data pathway is 16 bits (instead of 18 bits as with the QDUC half-band filters). As such, baseband quantization noise is higher in BFI mode.

Knowledge of the frequency response of the half-band filters is essential to understanding their impact on the spectral properties of the input signal. This is especially true when using the quadrature modulator to upconvert a baseband signal containing complex data symbols that have been pulse shaped.

Consider that a complex symbol is represented by a real (I) and an imaginary (Q) component, thus requiring two digital words to represent a single complex sample of the form I + jQ. The sample rate associated with a sequence of complex symbols is referred to as f_{SYMBOL}. If pulse shaping is applied to the symbols, the sample rate must be increased by some integer factor, M (a consequence of the pulse shaping process). This new sample rate (f_{IQ}) is related to the symbol rate by

$$f_{IQ} = Mf_{SYMBOL}$$

where f_{IQ} is the rate at which complex samples must be supplied to the input of the first half-band filter in both (I and Q) signal paths. This rate should not be confused with the rate at which data is supplied to the AD9957.

Typically, pulse shaping is applied to the baseband symbols via a filter having a raised cosine response. In such cases, an excess bandwidth factor ($α$, $0 ≤ α ≤ 1$) is used to modify the bandwidth of the data. For $α = 0$, the data bandwidth corresponds to $f_{SYMBOL}/2$; for $α = 1$, the data bandwidth extends to f_{SYMBOL}. Figure 36 shows the relationship between $α$, the bandwidth of the raised cosine response, and the response of the first half-band filter.

TYPICAL SPECTRUM OF A RANDOM SYMBOL SEQUENCE

NYQUIST BAND WIDTH

½f$_{SYMBOL}$ f$_{SYMBOL}$ 2f$_{SYMBOL}$ 3f$_{SYMBOL}$ f

RAISED COSINE SPECTRAL MASK

$α = 1$
$α = 0$ $α = 0.5$

SAMPLE RATE FOR 2× OVERSAMPLED PULSE SHAPING

½f$_{SYMBOL}$ f$_{SYMBOL}$ 2f$_{SYMBOL}$ 4f$_{SYMBOL}$ f

HALF-BAND FILTER RESPONSE

INPUT SAMPLE RATE OF FIRST HALF-BAND FILTER

INPUT SAMPLE RATE OF FIRST HALF-BAND FILTER

0.4f$_{IQ}$ ½f$_{IQ}$ f$_{IQ}$ 2f$_{IQ}$ f

06384-016
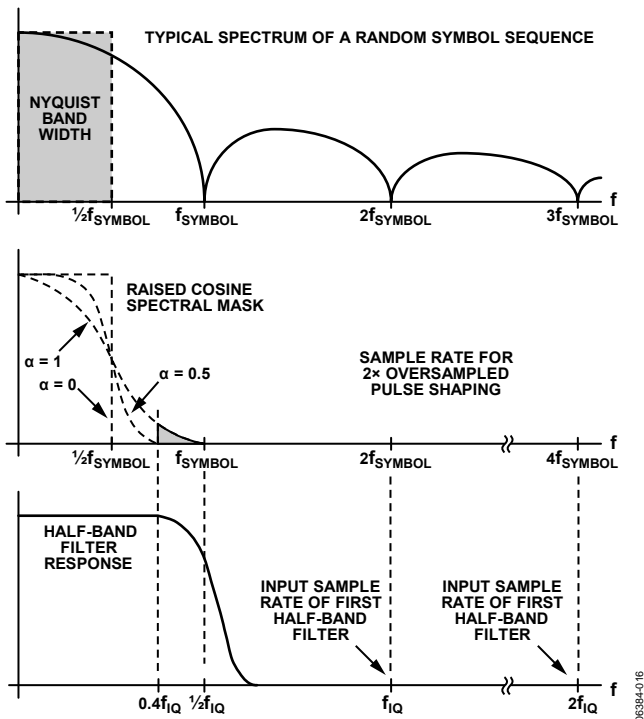
Figure 36. Effect of the Excess Bandwidth Factor (α)

The responses in Figure 36 reflect the specific case of M = 2 (the interpolation factor for the pulse shaping operation). Increasing Factor M shifts the location of the f_{IQ} point on the half-band

response portion of the diagram to the right, as it must remain aligned with the corresponding Mf_{SYMBOL} point on the frequency axis of the raised cosine spectral diagram. However, if f_{IQ} shifts to the right, so does the half-band response, proportionally.

The result is that the raised cosine spectral mask always lies within the flat portion (dc to $0.4 f_{IQ}$) of the pass band response of the first half-band filter, regardless of the choice of $α$ so long as M > 2. Therefore, for M > 2, the first half-band filter has absolutely no negative impact on the spectrum of the baseband signal when raised cosine pulse shaping is employed. For the case of M = 2, a problem can arise. This is highlighted by the shaded area in the tail of the $α = 1$ trace on the raised cosine spectral mask diagram. Notice that this portion of the raised cosine spectral mask extends beyond the flat portion of the half-band response and causes unwanted amplitude and phase distortion as the signal passes through the first half-band filter. To avoid this, simply ensure that $α ≤ 0.6$ when M = 2.

PROGRAMMABLE INTERPOLATING FILTER

The programmable interpolator is implemented as a low-pass CCI filter. It is programmable by a 6-bit control word, giving a range of 2× to 63× interpolation.

The programmable interpolator is bypassed when programmed for an interpolation factor of 1. When bypassed, power to the stage is removed and the inverse CCI filter is also bypassed, because its compensation is not needed.

The output of the programmable interpolator is the data from the 4× interpolator further upsampled by the CCI filter, according to the rate chosen by the user. This results in the upsampling of the input data by a factor of 8× to 252× in steps of four.

The transfer function of the CCI interpolating filter is

$$H(f) = \left(\sum_{k=0}^{R-1} e^{-j(2\pi fk)} \right)^5 \qquad (1)$$

where R is the programmed interpolation factor, and f is the frequency normalized to f_{SYSCLK}.

Note that minimum R requirements exist depending on the mode and frequency of f_{SYSCLK}. The minimum R setting is defined under the following conditions.

QDUC Mode

If f_{SYSCLK} is between 500 MSPS to 1 GSPS, then the minimum R is 2.

If f_{SYSCLK} is less than 500 MSPS, then the minimum R is 1.

BFI Mode

If f_{SYSCLK} is between 500 MSPS to 750 MSPS, then the minimum R is 3.

If f_{SYSCLK} is between 250 MSPS to 500 MSPS, then the minimum R is 2.

If f_{SYSCLK} is less than 250 MSPS, then the minimum R is 1.

QUADRATURE MODULATOR

The digital quadrature modulator stage shifts the frequency of the baseband spectrum of the incoming data stream up to the desired carrier frequency (a process known as upconversion).

At this point, the baseband data, which was delivered to the device at an I/Q sample rate of f_{IQ}, has been upsampled to a rate equal to the frequency of SYSCLK, making the data sampling rate equal to the sampling rate of the carrier signal.

The frequency of the carrier signal is controlled by a direct digital synthesizer (DDS). The DDS very precisely generates the desired carrier frequency from the internal reference clock (SYSCLK). The carrier is applied to the I and Q multipliers in quadrature fashion (90° phase offset) and summed, yielding a data stream that represents the quadrature modulated carrier.

The modulation is performed digitally, avoiding the phase offset, gain imbalance, and crosstalk issues commonly associated with analog modulators. Note that the modulated, so-called signal is a number stream sampled at the rate of SYSCLK, the same rate at which the DAC is clocked.

The orientation of the modulated signal with respect to the carrier is controlled by a spectral invert bit. This bit resides in each of the eight profile registers. By default, the time domain output of the quadrature modulator takes the form

$$I(t) \times \cos(\omega t) - Q(t) \times \sin(\omega t) \qquad (2)$$

When the spectral invert bit is asserted, it becomes

$$I(t) \times \cos(\omega t) + Q(t) \times \sin(\omega t) \qquad (3)$$

DDS CORE

The direct digital synthesizer (DDS) block generates sine and/or cosine signals. In single tone mode, the DDS generates either a digital sine or cosine waveform based on the select DDS sine output bit. In QDUC mode, the DDS generates the quadrature carrier reference signal that digitally modulates the I/Q baseband signal.

The DDS output frequency is tuned using registers accessed via the serial I/O port. This allows for both precise tuning and instantaneous changing of the carrier frequency.

The equation relating output frequency (f_{OUT}) of the DDS to the frequency tuning word (FTW) and the system clock (f_{SYSCLK}) is

$$f_{OUT} = \left(\frac{FTW}{2^{32}}\right) f_{SYSCLK} \qquad (4)$$

where FTW is a decimal number from 0 to 2,147,483,647 ($2^{31} - 1$).

Solving for FTW yields

$$FTW = round\left(2^{32}\left(\frac{f_{OUT}}{f_{SYSCLK}}\right)\right) \qquad (5)$$

where the *round()* function means to round the result to the nearest integer. For example, for f_{OUT} = 41 MHz and f_{SYSCLK} = 122.88 MHz, then FTW = 1,433,053,867 (0x556AAAAB).

In single tone mode, the DDS frequency, phase, and amplitude are all programmable via the serial I/O port. The amplitude is controlled by means of a digital multiplier using a 14-bit fractional scale value called the amplitude scale factor (ASF). The LSB weight is 2^{-14}, yielding a multiplier range of 0 to 0.99993896484375 ($1 - 2^{-14}$). To bypass the ASF multiplier, program the appropriate control register bit (see the details of CFR2<24> in the Register Bit Descriptions section). When bypassed, the ASF multiplier clocks are disabled to conserve power. The phase offset is controlled by means of a digital adder that uses a 14-bit offset value called the phase offset word (POW). The adder is situated between the phase accumulator and the angle-to-amplitude conversion logic in the DDS core. The adder applies the POW to the instantaneous phase values produced by the DDS phase accumulator. The adder is MSB aligned with the phase accumulator yielding an LSB weight of 2^{-14} (which equates to a resolution of ~0.022° or ~0.000383 radians). Both the ASF and the POW are available for each of the eight profiles.

INVERSE SINC FILTER

The sampled carrier data stream is the input to the digital-to-analog converter. The DAC output spectrum is shaped by the characteristic sin(x)/x (or sinc) envelope, due to the intrinsic zero-order hold effect associated with DAC-generated signals. The shape of the sinc envelope is well known and can be compensated for. This compensation is provided by the inverse sinc filter preceding the DAC.

The inverse sinc filter is implemented as a digital FIR filter. Its response characteristic very nearly matches the inverse of the sinc envelope, as shown in Figure 37 (along with the sinc envelope for comparison).

The inverse sinc filter is enabled through a bit in the register map. The filter tap coefficients are listed in Table 4. The filter predistorts the data prior to its arrival at the DAC to compensate for the sinc envelope that otherwise distorts the spectrum.

When the inverse sinc filter is enabled, it introduces a ~3.0 dB insertion loss. The inverse sinc compensation is effective for output frequencies up to 40% (nominally) of the DAC sample rate.

Table 4. Inverse Sinc Filter Tap Coefficients

Tap No.	Tap Value	Tap No.
1	−35	7
2	+134	6
3	−562	5
4	+6729	4

In Figure 37, it can be seen that the sinc envelope introduces a frequency dependent attenuation that can be as much as 4 dB at the Nyquist frequency (half of the DAC sample rate). Without the inverse sinc filter, the DAC output also suffers from the frequency dependent droop of the sinc envelope. The inverse sinc filter effectively flattens the droop to within ±0.05 dB as shown in Figure 38, which shows the corrected sinc response with the inverse sinc filter enabled.
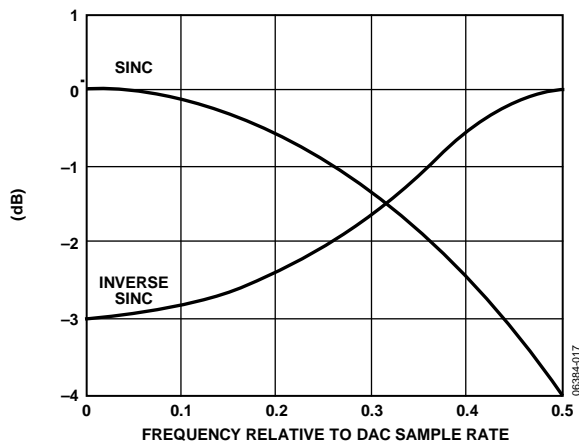
Figure 37. Sinc and Inverse Sinc Responses
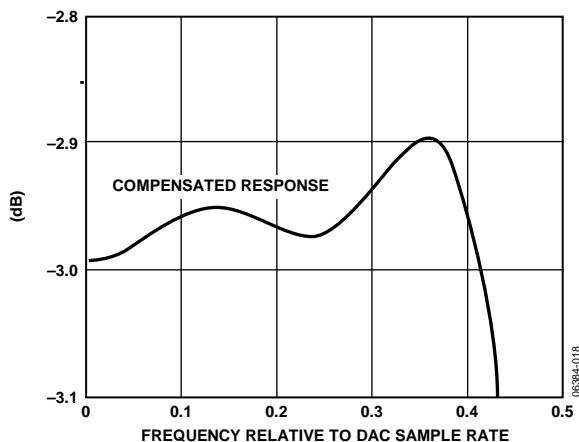
Figure 38. DAC Response with Inverse Sinc Compensation

OUTPUT SCALE FACTOR (OSF)

In QDUC and interpolating DAC modes, the output amplitude is controlled using an 8-bit digital multiplier. The 8-bit multiplier value is called the output scale factor (OSF) and is programmed via the appropriate control registers. It is available for each of the eight profiles. The LSB weight is 2^{-7}, which yields a multiplier range of 0 to 1.9921875 ($2 - 2^{-7}$). The gain extends to nearly a factor of 2 to provide a means to overcome the intrinsic loss through the modulator when operating in the quadrature modulation mode.

In interpolating DAC mode, the OSF should not be programmed to exceed unity, as clipping can result. Programming the 8-bit multiplier to unity gain (0x80) bypasses the stage and reduces power consumption.

14-BIT DAC

The AD9957 incorporates an integrated 14-bit current-output DAC. The output current is delivered as a balanced signal using two outputs. The use of balanced outputs reduces the amount of common-mode noise at the DAC output, increasing signal-to-noise ratio. An external resistor (R_{SET}) connected between the DAC_RSET pin and AGND establishes a reference current. The full-scale output current of the DAC (I_{OUT}) is a scaled version of the reference current (see the Auxiliary DAC section that follows).

Proper attention should be paid to the load termination to keep the output voltage within the specified compliance range, as voltages developed beyond this range cause excessive distortion and can damage the DAC output circuitry.

Auxiliary DAC

The full-scale output current of the main DAC (I_{OUT}) is controlled by an 8-bit auxiliary DAC. An 8-bit code word stored in the appropriate register map location sets I_{OUT} according to the following equation:

$$I_{OUT} = \frac{86.4}{R_{SET}}\left(1 + \frac{CODE}{96}\right) \qquad (6)$$

where:
R_{SET} is the value of the R_{SET} resistor (in ohms).
CODE is the 8-bit value supplied to the auxiliary DAC (default is 127).

For example, with R_{SET} = 10,000 and CODE = 127, I_{OUT} = 20.07 mA.

RAM CONTROL

RAM OVERVIEW

The AD9957 has an integrated 1024 × 32-bit RAM. This RAM is only accessible when the AD9957 is operating in QDUC or interpolating DAC mode. The RAM has two fundamental modes of operation: data entry/retrieve mode and playback mode. The mode is selected by programming the RAM Enable bit in CFR1 via the serial I/O port.

Data entry/retrieve mode is used to load or read back the RAM contents via the serial I/O port. Playback mode is used to deliver RAM data to one of two internal destinations: the baseband scaling multipliers (see Figure 25, the IS and QS labels) or the baseband signal chain (see Figure 25, the I and Q labels). In both cases, the RAM can be used to apply an arbitrary, time-varying waveform to the selected destination. A block diagram of the RAM and its control elements is shown in Figure 39.

The external parallel data port is disabled when the baseband signal chain serves as the RAM playback destination.
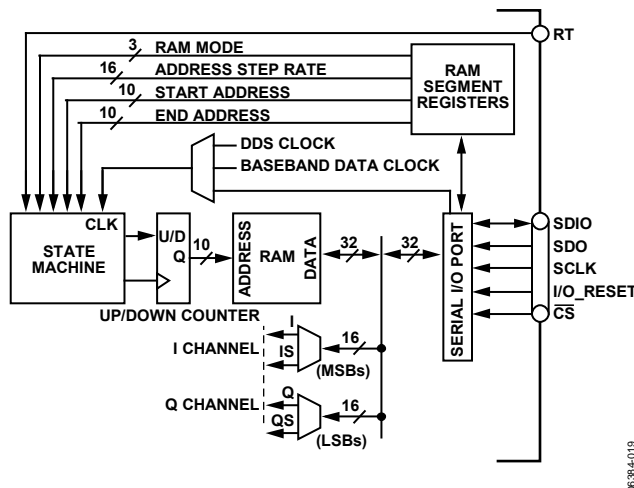
Figure 39. RAM Block Diagram

In Figure 39, the serial I/O port is used to program the contents of the two RAM segment registers as well as to load and retrieve the RAM contents. The state machine takes care of incrementing or decrementing the RAM address locations and controlling the timing of the RAM address and data for proper operation. The I-channel and Q-channel multiplexers route RAM data to baseband scaling multipliers (IS/QS) or directly to the baseband signal chain (I/Q) when the RAM is used in playback mode. The state of the RAM playback destination bit determines the destination of the RAM data during playback.

An I/O update (or a profile change) is necessary to enact a state change of the RAM enable or RAM playback destination bits, or any of the RAM segment register bits.

The 32-bit RAM data bus is partitioned so that the 16 MSBs are designated as I-channel bits and the 16 LSBs are designated as

Q-channel bits. In playback mode, when driving data directly into the baseband signal chain, the 16-bit data-words are considered to be signed (that is, twos complement) values. The 16-bit I-and Q-words are MSB aligned with the 18-bit I and Q baseband data path. The two remaining LSBs of each 18-bit baseband channel are driven by the MSB of the respective channel. This ensures correct polarity coding when the 16-bit I and Q data from the RAM translates into 18-bit words for the baseband signal chain. Alternatively, when the RAM is driving the baseband scaling multipliers in playback mode, the RAM data is considered to represent unsigned, fractional values with a range of 0 to $1 - 2^{-16}$.

RAM SEGMENT REGISTERS

Two dedicated registers (RAM Segment Register 0 and RAM Segment Register 1) control the operation of the RAM. Each contains the following:

- 10-bit start address word
- 10-bit end address word
- 16-bit address step rate word
- 3-bit RAM playback mode word

When programming these registers, the user must ensure that the end address is greater than the start address.

With the RAM segment registers, the user can arbitrarily partition the RAM into two independent memory segments. The segment boundaries are specified with the start and end address words in each RAM segment register. The playback rate is controlled by the address step rate word (only meaningful when the baseband scaling multipliers serve as the playback destination). If the baseband signal chain serves as the RAM playback destination, the 16-bit address step rate words must be set to 1. The playback mode of the RAM is controlled via the RAM playback mode word.

RAM STATE MACHINE

The state machine acts as an address generator for the RAM. It is clocked by either the serial I/O port (when the RAM is operating in the load/retrieve mode) or the baseband data clock (when the RAM is in playback mode). The state machine uses the RAM mode bits of the active RAM segment register to establish the proper sequence through the specified address range.

RAM TRIGGER (RT) PIN

The RAM state machine monitors the RT pin for logic state transitions. Any state transition triggers the state machine into action.

The direction of the logic state transition on the RT pin determines which RAM segment register the state machine uses for playback instructions. RAM Segment Register 0 is used if the state machine detects a 0-to-1 transition; RAM Segment Register 1 is used if a 1-to-0 transition is detected.

LOAD/RETRIEVE RAM OPERATION

Loading or retrieving the RAM contents is a three-step process.

1. Program the RAM segment registers with start and end addresses defining the boundaries of each independent RAM segment.

2. Toggle the RT pin with the appropriate transition to select the desired RAM segment register.

3. Using the serial I/O port, write (or read) the address range specified by the selected RAM segment register.

Figure 40 shows the RAM block diagram when used for loading or retrieve operations.

NOTES
1. NONESSENTIAL FUNCTIONAL COMPONENTS ARE RENDERED IN GRAY.
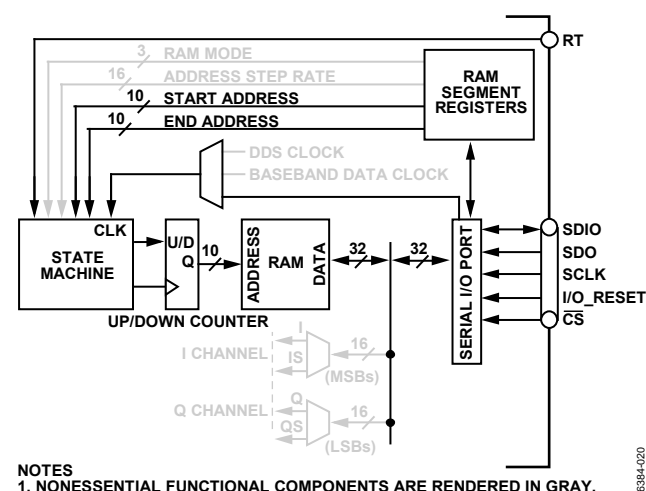
Figure 40. RAM Load/Retrieve Operation

During a load or retrieve operation, the state machine controls an up/down counter to step through the required RAM locations. The counter is synchronized with the serial I/O port so that the serial/parallel conversion of the 32-bit words is correctly timed with the generation of the appropriate RAM address to properly execute the desired read or write operation. The up/down counter always increments through the address range during serial I/O port operations.

Because the RAM segment registers are completely independent, it is possible to define overlapping address ranges. However, doing so causes the overlapping address locations to be over-written by the most recent write operation. It is recommended that the user avoid defining overlapping address ranges.

RAM PLAYBACK OPERATION

When the RAM has been loaded, it can be used for playback operation. The destination of the playback data is selected via the RAM playback destination bit. The active RAM segment register is selected by the appropriate transition of the RT pin. The active RAM segment register directs the internal state machine by defining the RAM address range occupied by the data and the RAM playback mode. It also defines the playback

rate when the playback destination is the baseband scaling multipliers.

Although RAM load/retrieve operations via the serial I/O port take precedence over playback, it is recommended that the user not attempt RAM access via the serial I/O port when the RAM enable bit is set.

Figure 41 is a block diagram showing the functional components used for RAM playback operation when the internal destination is the baseband scaling multipliers.
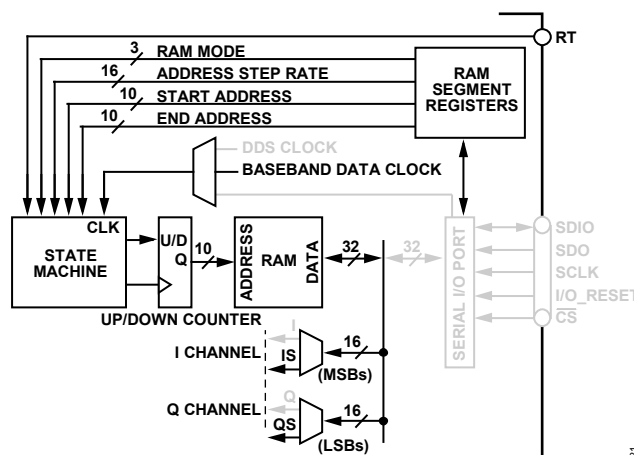
NOTES
1. NONESSENTIAL FUNCTIONAL COMPONENTS ARE RENDERED IN GRAY.

Figure 41. RAM Playback to Baseband Scaling Multipliers

During playback to the baseband scaling multipliers, the address step rate word in the active RAM segment register sets the rate at which RAM data samples are delivered to the multipliers. The following equations define the RAM sample rate and sample interval (Δt):

$$RAM\ Sample\ Rate = \frac{f_{SYSCLK}}{4RM}$$

$$\Delta t = \frac{4RM}{f_{SYSCLK}}$$

where:
R is the rate interpolation factor for the CCI filter.
M is the 16-bit value of the address step rate word stored in the active RAM segment register.

If the RAM enable bit is set and the baseband scaling multipliers are selected as the playback destination, then assertion of an I/O update or profile change causes the multipliers to be driven with a static value of zero. A subsequent state change on the RT pin causes the multipliers to be driven by the data played back from the RAM instead of the static zero value.

Figure 42 is a block diagram showing RAM playback operation when the internal destination is the baseband data path. During playback to the baseband data path, the state machine increments/decrements the RAM address at the baseband data rate (the address step rate must be set to 1).
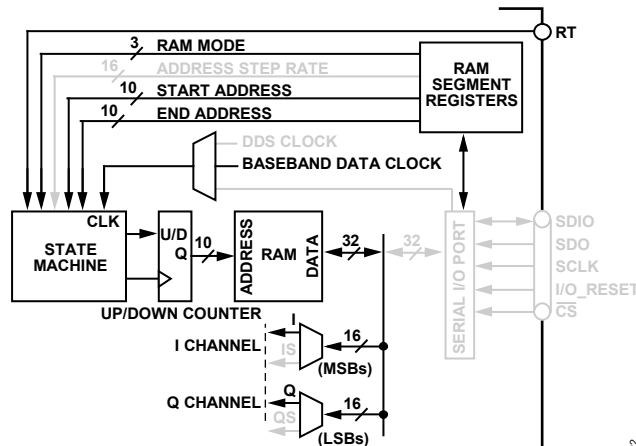
NOTES
1. NONESSENTIAL FUNCTIONAL COMPONENTS ARE RENDERED IN GRAY.

Figure 42. RAM Playback to Baseband Data Path

OVERVIEW OF RAM PLAYBACK MODES

The RAM is operational in any one of four different playback modes.

- Ramp-up
- Bidirectional ramp
- Continuous bidirectional ramp
- Continuous recirculate

RAM playback is only functional when the AD9957 is programmed for either the QDUC or interpolating DAC mode.

The RAM playback mode is selected via the 3-bit RAM playback mode word located in each of the RAM segment registers. Thus, the RAM playback mode is segment dependent. The RAM playback mode bits are detailed in Table 5.

Table 5. RAM Playback Modes

RAM Playback Mode Bits<2:0>	RAM Playback Mode
001	Ramp-up
010	Bidirectional ramp
011	Continuous bidirectional ramp
100	Continuous recirculate
000, 101, 110, 111	Not Valid

The continuous bidirectional ramp and continuous recirculate modes are not available when the baseband scaling multipliers serve as the destination of RAM playback.

RAM Ramp-Up Mode

In ramp-up mode, upon assertion of an I/O update or a state change on the RT pin, the RAM begins playback operation using the parameters programmed into the selected RAM segment register. Data is extracted from RAM over the specified address range contained in the start address and end address of the active RAM segment register. The data is delivered at the appropriate rate and to the destination as specified by the RAM playback destination bit.

The playback rate is governed by the timer internal to the RAM state machine and its period (Δt) is determined by the state of the RAM playback destination bit as detailed in the RAM Playback Operation section.

The internal state machine begins extracting data from the RAM at the start address and continues to extract data until it reaches the end address. Upon reaching this address, the state machine halts.

A graphic representation of the ramp-up mode appears in Figure 43. The upper trace shows the progression of the RAM address from the start address to the end address for the active RAM segment register. The address value advances by one with each timeout of the timer internal to the state machine. The circled numbers indicate specific events, explained as follows:

Event 1—an I/O update or state transition on the RT pin. This event initializes the state machine to the start address of the active RAM segment register.

Event 2—the state machine reaches the end address of the active RAM segment register and halts.
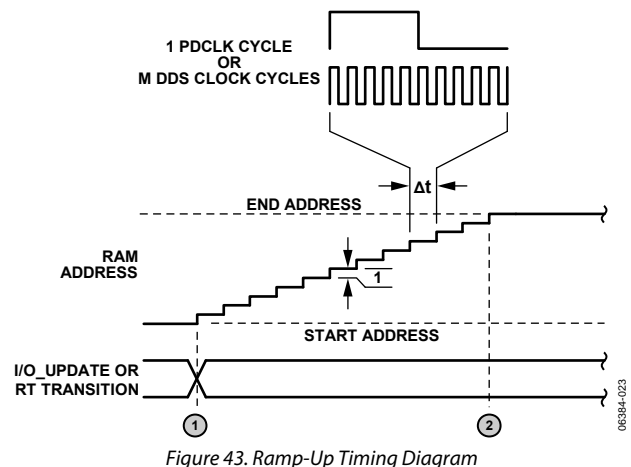
Figure 43. Ramp-Up Timing Diagram

RAM Bidirectional Ramp Mode

This mode is unique in that the RAM segment playback mode word of both RAM segment registers must be programmed for RAM bidirectional ramp mode.

In bidirectional ramp mode, upon assertion of an I/O update, the RAM readies for playback operation using the parameters programmed into RAM Segment Register 0. The data is delivered at the appropriate rate and to the destination as specified by the RAM playback destination bit.

The playback rate is governed by the timer that is internal to the RAM state machine, and its period (Δt) is determined by the state of the RAM playback destination bit as detailed in the RAM Playback Operation section.

Playback begins upon a 0 to 1 logic transition on the RT pin. This instructs the state machine to increment through the address range specified in RAM Segment Register 0 starting with the start address. As long as the RT pin remains Logic 1, the state machine continues to play back the RAM data until it reaches the end address, at which point the state machine halts.

A Logic 1 to Logic 0 transition on the RT pin instructs the state machine to switch to RAM Segment Register 1 and to decrement through the address range starting with the end address. As long as the RT pin remains Logic 0, the state machine continues to play back the RAM data until it reaches the start address, at which point the state machine halts.

It is important to note that RAM Segment Register 1 is played back in reverse order for bidirectional ramp mode. This must be kept in mind when the RAM contents are loaded via the serial I/O port when bidirectional ramp mode is the intended playback mode.

A graphic representation of the bidirectional ramp mode appears in Figure 44. It demonstrates the action of the state machine in response to the RT pin. If the RT pin changes states before the state machine reaches the programmed start or end address, the internal timer is restarted and the direction of the address counter reversed.
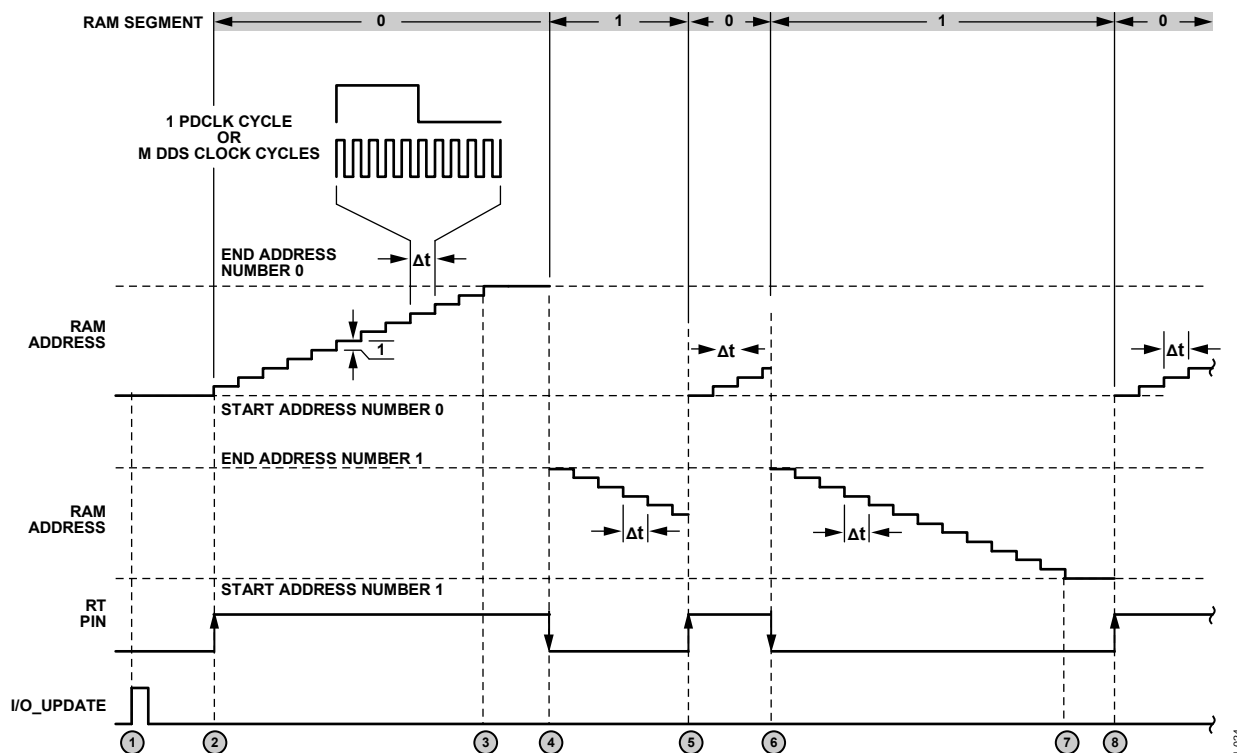
Figure 44. Bidirectional Ramp Timing Diagram

The circled numbers in Figure 44 indicate specific events, explained as follows:

Event 1—an I/O update or profile change activates the RAM bidirectional ramp mode.

Event 2—the RT pin switches to Logic 1. The state machine initializes to the start address of RAM Segment Register 0 and begins incrementing the RAM address counter.

Event 3—the RT pin remained at Logic 1 long enough for the state machine to reach the end address of RAM Segment Register 0, at which point the address counter is halted.

Event 4—the RT pin switches to Logic 0. The state machine initializes to the end address of RAM Segment Register 1, resets the internal timer, and begins decrementing the RAM address counter.

Event 5—the RT pin switches to Logic 1. The state machine initializes to the start address of RAM Segment Register 0, resets the internal timer, and begins incrementing the RAM address counter.

Event 6—the RT pin switches to Logic 0. The state machine initializes to the end address of RAM Segment Register 1, resets the internal timer, and begins decrementing the RAM address counter.

Event 7—the RT pin remained at Logic 0 long enough for the state machine to reach the start address of RAM Segment Register 1, at which point the address counter is halted.

Event 8—the RT pin switches to Logic 1. The state machine initializes to the start address of RAM Segment Register 0, resets the internal timer, and begins incrementing the RAM address counter.
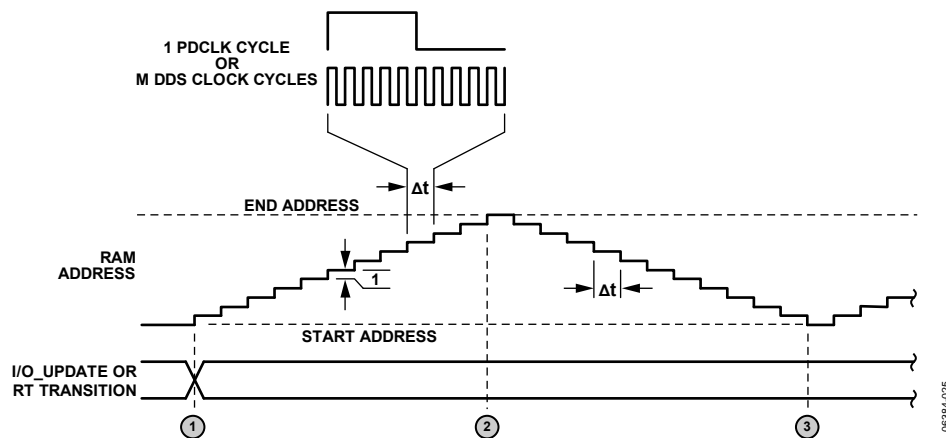
Figure 45. Continuous Bidirectional Ramp Timing Diagram

RAM Continuous Bidirectional Ramp Mode

In continuous bidirectional ramp mode, upon assertion of an I/O update or a state change on the RT pin, the RAM begins playback operation using the parameters programmed into the selected RAM segment register. Data is extracted from RAM over the specified address range contained in the start address and end address. The data is delivered at the appropriate rate and to the destination as specified by the RAM playback destination bit.

The playback rate is governed by the timer internal to the RAM state machine and its period (Δt) is determined by the state of the RAM playback destination bit as detailed in the RAM Playback Operation section.

After initialization, the internal state machine begins extracting data from the RAM at the start address of the active RAM segment register and increments the address counter until it reaches the end address, at which point the state machine reverses the direction of the address counter and begins decrementing through the address range. Whenever one of the terminal addresses is reached, the state machine reverses the address counter; the process continues indefinitely.

Note that a change in state of the RT pin aborts the current waveform and the newly selected RAM segment register is used to initiate a new waveform.

A graphic representation of the continuous bidirectional ramp mode is shown in Figure 45. The circled numbers in Figure 45 indicate specific events, explained as follows:

Event 1—an I/O update or state change on the RT pin has activated the RAM continuous bidirectional ramp mode. The state machine initializes to the start address of the active RAM segment register. The state machine begins incrementing through the specified address range.

Event 2—the state machine reaches the end address of the active RAM segment register.

Event 3—the state machine reaches the start address of the active RAM segment register.

The continuous bidirectional ramp continues indefinitely until the next I/O update or state change on the RT pin.
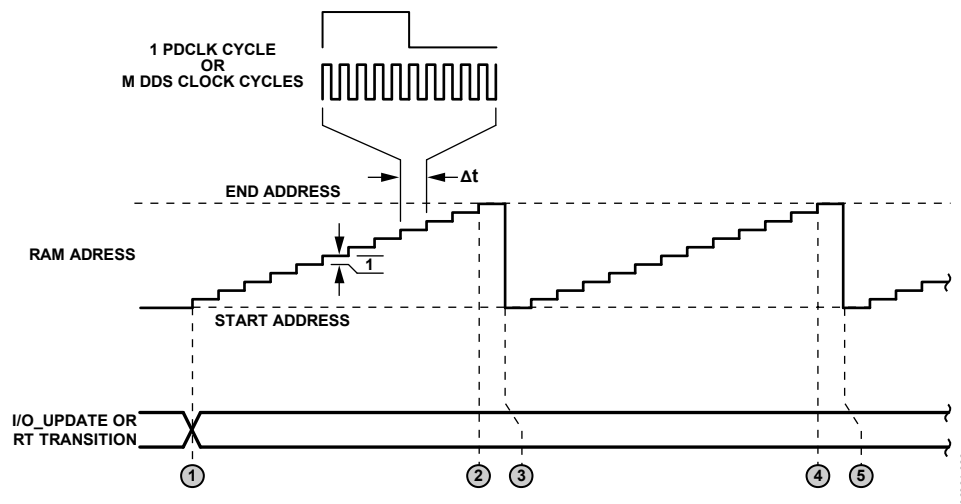
Figure 46. Continuous Recirculate Timing Diagram

RAM Continuous Recirculate Mode

The continuous recirculate mode mimics ramp-up mode, except that when the state machine reaches the end address of the active RAM segment register, it does not halt. Instead, the next timeout of the internal timer causes the state machine to jump to the start address of the active RAM segment register. This process continues indefinitely until an I/O update or state change on the RT pin. A state change on the RT pin aborts the current waveform and the newly selected RAM segment register initiates a new waveform.

A graphic representation of the continuous recirculate mode is shown in Figure 46.

The circled numbers in Figure 46 indicate specific events, which are explained as follows:

Event 1—an I/O update or state change on the RT pin occurs. This initializes the state machine to the start address of the

active RAM segment register and causes the state machine to begin incrementing the address counter at the appropriate rate.

Event 2—the state machine reaches the end address of the active RAM segment register.

Event 3—the state machine switches to the start address of the active RAM segment register. The state machine continues to increment the address counter.

Event 4—the state machine again reaches the end address of the active RAM segment register.

Event 5—the state machine switches to the start address of the active RAM segment register. The state machine continues to increment the address counter.

Event 4 and Event 5 repeat until an I/O update or state change occurs on the RT pin.

CLOCK INPUT (REF_CLK)

REFCLK OVERVIEW

The AD9957 supports a number of options for producing the internal SYSCLK signal (that is, the DAC sample clock) via the REF_CLK/$\overline{\text{REF\_CLK}}$ input pins. The REF_CLK input can be driven directly from a differential or single-ended source, or it can accept a crystal connected across the two input pins. There is also an internal phase-locked loop (PLL) multiplier that can be independently enabled. A block diagram of the REF_CLK functionality is shown in Figure 47. The various input configurations are controlled by means of the XTAL_SEL pin and control bits in the CFR3 register. Figure 47 also shows how the CFR3 control bits are associated with specific functional blocks.
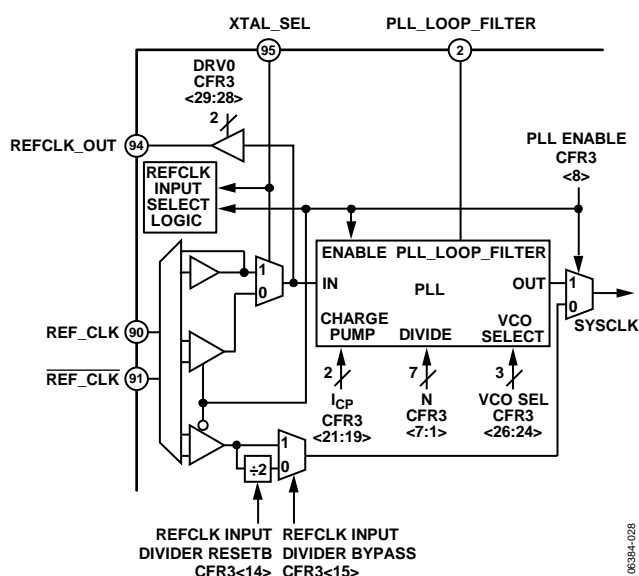
Figure 47. REF_CLK Block Diagram

The PLL enable bit is used to choose between the PLL path or the direct input path. When the direct input path is selected, the REF_CLK/$\overline{\text{REF\_CLK}}$ pins must be driven by an external signal source. Input frequencies up to 2 GHz are supported. For input frequencies greater than 1 GHz, the input divider must be enabled for proper operation of the device.

When the PLL is enabled, a buffered clock signal is available at the REFCLK_OUT pin. This clock signal is the same frequency as the REF_CLK input. This is especially useful when a crystal is connected, because it gives the user a replica of the crystal clock for driving other external devices. The REFCLK_OUT buffer is controlled by two bits as listed in Table 6.

Table 6. REFCLK_OUT Buffer Control

CFR3<29:28>	REFCLK_OUT Buffer
00	Disabled
01	Low output current
10	Medium output current
11	High output current

CRYSTAL DRIVEN REF_CLK

When using a crystal at the REF_CLK input, the resonant frequency should be approximately 25 MHz. Figure 48 shows the recommended circuit configuration.
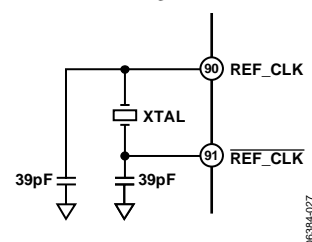
Figure 48. Crystal Connection Diagram

DIRECT DRIVEN REF_CLK

When driving the REF_CLK/$\overline{\text{REF\_CLK}}$ inputs directly from a signal source, either single-ended or differential signals can be used. With a differential signal source, the REF_CLK/$\overline{\text{REF\_CLK}}$ pins are driven with complementary signals and ac-coupled with 0.1 μF capacitors. With a single-ended signal source, either a single-ended-to-differential conversion can be employed or the REF_CLK input can be driven single-ended directly. In either case, 0.1 μF capacitors are used to ac couple both REF_CLK/$\overline{\text{REF\_CLK}}$ pins to avoid disturbing the internal dc bias voltage of ~1.35 V. See Figure 49 for more details.

The REF_CLK/$\overline{\text{REF\_CLK}}$ input resistance is ~2.5 kΩ differential (~1.2 kΩ single-ended). Most signal sources have relatively low output impedances. The REF_CLK/$\overline{\text{REF\_CLK}}$ input resistance is relatively high; therefore, its effect on the termination impedance is negligible and can usually be chosen to be the same as the output impedance of the signal source. The bottom two examples in Figure 49 assume a signal source with a 50 Ω output impedance.
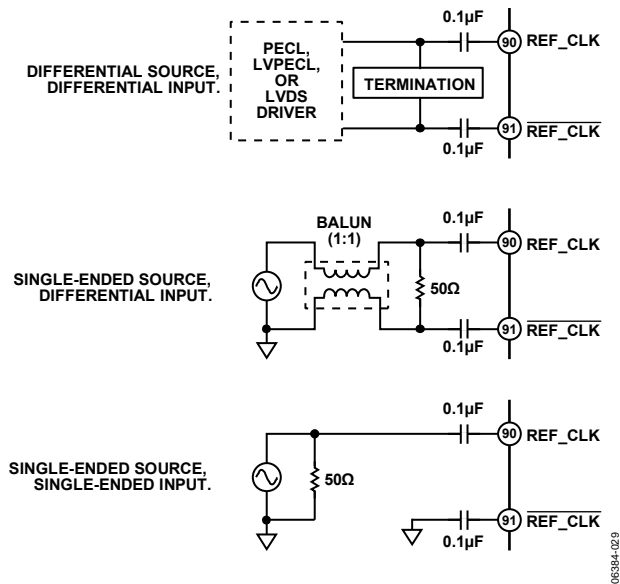
Figure 49. Direct Connection Diagram

PHASE-LOCKED LOOP (PLL) MULTIPLIER

An internal phase-locked loop (PLL) provides users of the AD9957 the option to use a reference clock frequency that is significantly lower than the system clock frequency. The PLL supports a wide range of programmable frequency multiplication factors (12× to 127×) as well as a programmable charge pump current and external loop filter components (connected via the PLL_LOOP_FILTER pin). These features add an extra layer of flexibility to the PLL, allowing optimization of phase noise performance and flexibility in frequency plan development. The PLL is also equipped with a PLL_LOCK pin.

The PLL output frequency range (f_{SYSCLK}) is constrained to the range of 420 MHz ≤ f_{SYSCLK} ≤ 1 GHz by the internal VCO. In addition, the user must program the VCO to one of six operating ranges such that f_{SYSCLK} falls within the specified range. Figure 50 and Figure 51 summarize these VCO ranges.

Figure 50 shows the boundaries of the VCO frequency ranges over the full range of temperature and supply voltage variation for all devices from the available population. The implication is that multiple devices chosen at random from the population and operated under widely varying conditions may require different values to be programmed into CFR3<26:24> to operate at the same frequency. For example, Part A chosen randomly from the population, operating in an ambient temperature of −10°C with a system clock frequency of 900 MHz may require CFR3<26:24> to be set to 100b. Whereas Part B chosen randomly from the population, operating in an ambient temperature of 90°C with a system clock frequency of 900 MHz may require CFR3<26:24> to be set to 101b. If a frequency plan is chosen such that the system clock frequency operates within one set of boundaries (as shown in Figure 51), the required value in CFR3<26:24> is consistent from part to part.

Figure 51 shows the boundaries of the VCO frequency ranges over the full range of temperature and supply voltage variation for an individual device selected from the population. Figure 51 shows that the VCO frequency ranges for a single device always overlap when operated over the full range of conditions.

In conclusion, if a user wants to retain a single default value for CFR3<26:24>, a frequency that falls into one of the ranges found in Figure 50 should be selected. Additionally, for any given individual device, the VCO frequency ranges overlap, meaning that any given device exhibits no gaps in its frequency coverage across VCO ranges over the full range of conditions.
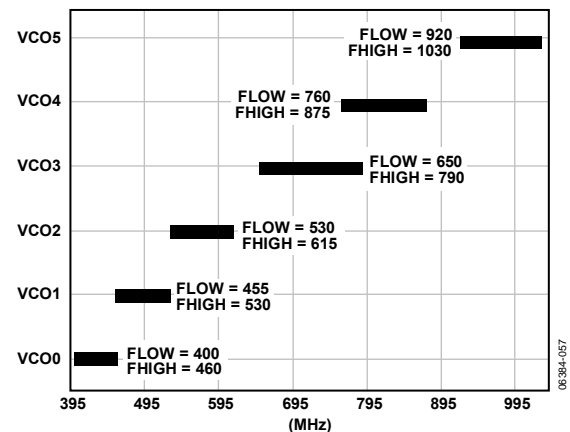
Figure 50. VCO Ranges Including Atypical Wafer Process Skew
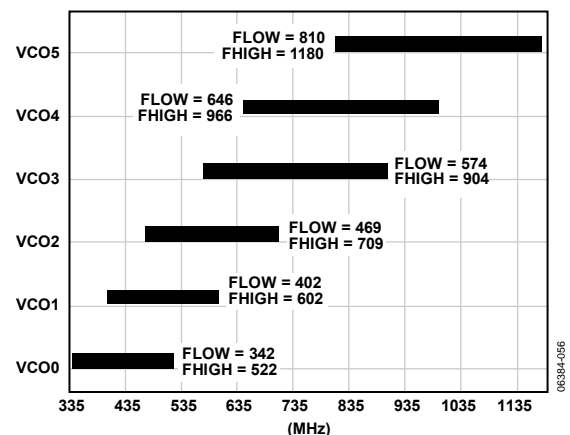
Figure 51. Typical VCO Ranges

Table 7. VCO Range Bit Settings

VCO SEL Bits (CFR3<26:24>)	VCO Range
000	VCO0
001	VCO1
010	VCO2
011	VCO3
100	VCO4
101	VCO5
110	PLL Bypassed
111	PLL Bypassed

PLL CHARGE PUMP

The charge pump current (I_{CP}) is programmable to provide the user with additional flexibility to optimize the PLL performance. Table 8 lists the bit settings vs. the nominal charge pump current.

Table 8. PLL Charge Pump Current

I_{CP} (CFR3<21:19>)	Charge Pump Current, I_{CP} (µA)
000	212
001	237
010	262
011	287
100	312
101	337
110	363
111	387

EXTERNAL PLL LOOP FILTER COMPONENTS

The PLL_LOOP_FILTER pin provides a connection interface to attach the external loop filter components. The ability to use custom loop filter components gives the user more flexibility to optimize the PLL performance. The PLL and external loop filter components are shown in Figure 52.
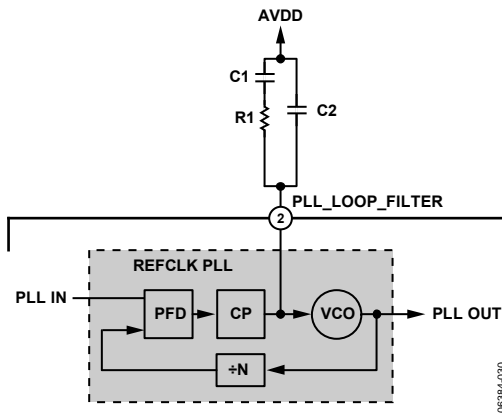
Figure 52. REFCLK PLL External Loop Filter

In the prevailing literature, this configuration yields a third-order, Type II PLL. To calculate the loop filter component values, begin with the feedback divider value (N), the gain of the phase detector (K_D), and the gain of the VCO (K_V) based on the programmed VCO SEL bit settings (see Table 1 for K_V). The loop filter component values depend on the desired open-loop bandwidth (f_{OL}) and phase margin (φ), as follows:

$$R1 = \frac{\pi N f_{OL}}{K_D K_V}\left(1 + \frac{1}{\sin(\varphi)}\right) \tag{7}$$

$$C1 = \frac{K_D K_V \tan(\phi)}{2N(\pi f_{OL})^2} \tag{8}$$

$$C2 = \frac{K_D K_V}{N(2\pi f_{OL})^2}\left(\frac{1 - \sin(\varphi)}{\cos(\varphi)}\right) \tag{9}$$

where:
K_D equals the programmed value of I_{CP}.
K_V is taken from Table 1.

Ensure that proper units are used for the variables in Equation 7 through Equation 9. I_{CP} must be in amps, not µA as appears in Table 8; K_V must be in Hz/V, not MHz/V as listed in Table 1; the loop bandwidth (f_{OL}) must be in Hz; the phase margin (φ) must be in radians. Furthermore, to limit the phase noise contribution of the internal VCO, the loop bandwidth must be 1 MHz or greater.

For example, suppose the PLL is programmed such that $I_{CP} = 287$ µA, $K_V = 850$ MHz/V, and N = 25. If the desired loop bandwidth and phase margin are 1 MHz and 45°, respectively, the loop filter component values are R1 = 777.3 Ω, C1 = 494.3 pF, and C2 = 102.4 pF.

PLL LOCK INDICATION

When the PLL is in use, the PLL_LOCK pin provides an active high indication that the PLL has locked to the REFCLK input signal. When the PLL is bypassed, the PLL_LOCK pin defaults to Logic 0.

ADDITIONAL FEATURES

OUTPUT SHIFT KEYING (OSK)

The OSK function (Figure 53) is only available in single tone mode. It allows the user to control the output signal amplitude of the DDS. Both manual and automatic modes are available.
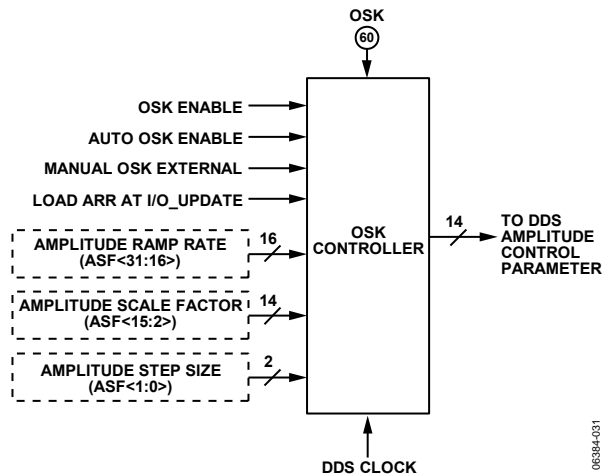
Figure 53. OSK Block Diagram

The operation of the OSK function is governed by four control register bits, the external OSK pin, and the entire 32 bits of the ASF register. The primary control for the OSK block is the OSK enable bit. When this bit is set, the OSK function is enabled; otherwise, the OSK function is disabled. When disabled, the other OSK input controls are ignored and the internal clocks are shut down to conserve power.

When the OSK function is enabled, automatic and manual operation is selected via the Select Auto-OSK bit. When this bit is set, the automatic mode is active; otherwise, the manual mode is active.

Manual OSK

In manual mode, output amplitude is varied by successive write operations to the amplitude scale factor portion of the ASF register. The rate at which amplitude changes can be applied to the output signal is limited by the speed of the serial I/O port. In manual mode, the OSK pin functionality depends on the state of the manual OSK external control bit. It is either inoperative or used to switch the output amplitude between the programmed amplitude scale factor value and zero. When operational, a Logic 0 on the OSK pin forces the output amplitude to zero whereas a Logic 1 on the OSK pin causes the output amplitude to be scaled by the amplitude scale factor value.

Automatic OSK

In automatic mode, the OSK function automatically generates a linear amplitude vs. time profile (or amplitude ramp). The amplitude ramp is controlled via three parameters, as follows:

- The maximum amplitude scale factor
- The amplitude step size
- The time interval between steps

The amplitude ramp parameters reside in the 32-bit ASF register and are programmed via the serial I/O port. The amplitude step interval is set using the 16-bit amplitude ramp rate portion of the ASF register (Bits<31:16>). The maximum amplitude scale factor is set using the 14-bit amplitude scale factor in the ASF register (Bits<15:2>). The amplitude step size is set using the 2-bit amplitude step size portion of the ASF register (Bits<1:0>). The direction of the ramp (positive or negative slope) is controlled by the external OSK pin. When the OSK pin is a Logic 1, the slope is positive; otherwise, it is negative.

The step interval is controlled by a 16-bit programmable timer that is clocked at a rate of ¼ f_{SYSCLK}. The timer period sets the interval between amplitude steps. The step time interval (Δt) is given by

$$\Delta t = \frac{4M}{f_{SYSCLK}}$$

where M is the 16-bit number stored in the amplitude ramp rate portion of the ASF register. For example, if f_{SYSCLK} = 750 MHz and M = 23,218 (0x5AB2), then $\Delta t \approx 123.8293$ µs.

The output of the OSK function is a 14-bit unsigned data bus that controls the amplitude of the DDS output (as long as the OSK enable bit is Logic 1). When the OSK pin is Logic 1, the OSK output value starts at 0 and increments by the programmed amplitude step size until it reaches the programmed maximum amplitude value. When the OSK pin is Logic 0, the OSK output starts at its present value and decrements by the programmed amplitude step size until it reaches 0.

The OSK output does not necessarily attain the maximum amplitude—the OSK pin may switch to Logic 0 before attaining the maximum value.

The OSK output does not necessarily reach a value of zero—the OSK pin may switch to Logic 1 before attaining the zero value.

The OSK output is initialized to 0 at power-up. It is also set to 0 when the OSK enable bit is Logic 0 or when the OSK enable bit is Logic 1, but the Select Auto-OSK bit is Logic 0.

The amplitude step size of the OSK output is set by the amplitude step size bits in the ASF register according to the values listed in Table 9. The step size refers to the LSB weight of the 14-bit OSK output.

The OSK output cannot exceed the maximum amplitude value programmed into the ASF register.

Table 9. OSK Amplitude Step Size

ASF<1:0>	Amplitude Step Size
00	1
01	2
10	4
11	8

As mentioned earlier, the step interval is controlled by a 16-bit programmable timer. Normally, this timer is loaded with the programmed timing value whenever the timer expires, thus initiating a new timing cycle. However, three events cause the timer to have its timing value reloaded prior to the timer expiring. One such event is when the Select Auto-OSK bit is transitioned from a Logic 0 state to a Logic 1 state followed by an I/O update. A second such event is a change of state in the OSK pin. The third event is dependent on the status of the Load ARR @ I/O Update bit. If this bit is Logic 0, no action occurs; otherwise, when the I/O_UPDATE pin is asserted (or a profile change occurs), the timer resets to its initial starting point.

PROFILES

Each of the three operating modes of the AD9957 support the use of profiles, which consist of a group of registers containing pertinent operating parameters for a particular operating mode. Profiles enable rapid switching between parameter sets. Profile parameters are programmed via the serial I/O port. Once programmed, a specific profile is activated by means of three external pins (PROFILE<2:0>). A particular profile is activated by providing the appropriate logic levels to the profile control pins per the settings listed in Table 10.

Table 10. Profile Control Pins

PROFILE<2:0>	Active Profile
000	0
001	1
010	2
011	3
100	4
101	5
110	6
111	7

Consider an application of basic two-tone frequency shift keying (FSK) where binary data is transmitted by selecting between two different frequencies: a mark frequency (Logic 1) and a space frequency (Logic 0). To accommodate FSK, the Profile 0 register is programmed with the appropriate frequency tuning word for a space, and the Profile 1 register is programmed with the appropriate frequency tuning word for a mark. Then, with the PROFILE1 and PROFILE2 pins tied to Logic 0, the PROFILE0 pin is used to transmit the data bits. The logic state of the PROFILE0 pin causes the appropriate mark and space frequencies to be generated.

I/O_UPDATE PIN

By default, the I/O_UPDATE pin is an input that serves as a strobe signal to allow synchronous update of the device operating parameters. For example, frequency, phase, and amplitude control words for the DDS can be programmed using the serial I/O port. However, the serial I/O port is an asynchronous interface; consequently, programming of the device operating parameters using the I/O port is not synchronized with the internal timing. Using the pin, I/O_UPDATE, the user can synchronize the application of certain programmed operating parameters with external circuitry when new parameters are programmed into the I/O registers. A rising edge on I/O_UPDATE initiates transfer of the register contents to the internal workings of the device.

The transfer of programmed data from the programming registers to the internal hardware is also accomplished by changing the state of the profile pins.

AUTOMATIC I/O UPDATE

The AD9957 offers an option whereby the I/O update function is asserted automatically rather than relying on an external signal supplied by the user. This feature is enabled by setting the Internal I/O Update Active bit in CFR2.

When this feature is active, the I/O_UPDATE pin becomes an output pin. It generates an active high pulse each time an internal I/O update occurs. The duration of the pulse is approximately 12 cycles of SYSCLK. This I/O update strobe can be used to notify an external controller that the device has generated an I/O update internally.

The repetition rate of the internal I/O update is programmed via the serial I/O port. Two parameters control the repetition rate. The first parameter consists of the two I/O update rate control bits in CFR2. The second parameter is the 32-bit word in the I/O update rate register that sets the range of an internal counter.

The I/O update rate control bits establish a divide by 1, 2, 4, or 8 of a clock signal that runs at ¼ f_{SYSCLK}. The output of the divider clocks the aforementioned 32-bit internal counter. The repetition rate of the I/O update is given by

$$f_{I/O\_UPDATE} = \frac{f_{SYSCLK}}{2^A B}$$

where:
A is the value of the 2-bit word comprising the I/O update rate control bits.
B is the value of the 32-bit word stored in the I/O update rate register.

If B is programmed to 0x0003 or less, the I/O_UPDATE pin no longer pulses, but assumes a static Logic 1 state.

POWER-DOWN CONTROL

The AD9957 offers the ability to independently power down four specific sections of the device. Power-down functionality applies to the digital core, DAC, auxiliary DAC, and REFCLK input.

A power-down of the digital core disables the ability to update the serial I/O port. However, the digital power-down bit can still be cleared via the serial port to prevent the possibility of a nonrecoverable state.

Software power-down is controlled through four independent power-down bits in CFR1. Software control requires forcing the EXT_PWR_DWN pin to a Logic 0 state. In this case, setting the desired power-down bits (via the serial I/O port) powers down the associated functional block; clearing the bits restores the function.

Alternatively, all four functions can be simultaneously powered down via external hardware control through the EXT_PWR_DWN pin. Forcing this pin to Logic 1 powers down all four circuit blocks, regardless of the state of the power-down bits. That is, the independent power-down bits in CFR1 are ignored and overridden when EXT_PWR_DWN is Logic 1.

Based on the state of the external power-down control bit, the EXT_PWR_DWN pin produces either a full power-down or a fast recovery power-down. The fast recovery power-down mode maintains power to the DAC bias circuitry and the PLL, VCO, and input section of the REFCLK circuitry. Although the fast recovery power-down does not conserve as much power as the full power-down, it allows the device to very quickly awaken from the power-down state.

GENERAL-PURPOSE I/O (GPIO) PORT

The GPIO function is only available when the AD9957 is programmed for QDUC mode and the Blackfin interface mode is active. Because the Blackfin serial interface uses only two of the 18 parallel data port pins (D<5:4>), the remaining 16 pins (D<17:6> and D<3:0>) are available as a GPIO port.

Each of these 16 pins is assigned a unique bit in both the 16-bit GPIO configuration register and the 16-bit GPIO data register. The status of each bit in the GPIO configuration register assigns the associated pin as either a GPIO input or output (0 = input, 1 = output) based on the data listed in Table 11.

When a GPIO pin is programmed as an output, the logic state written to the associated bit of the GPIO data register (via the serial I/O port) appears at the GPIO pin. When a GPIO pin is programmed as an input, the logic state of the GPIO pin can be read (via the serial I/O port) in the associated bit position in the GPIO data register. Note that the GPIO data register does not require an I/O update.

Table 11. GPIO Pins vs. Configuration and Data Register Bits

Pin Label	Configuration Bit	Data Bit
D17	15	15
D16	14	14
D15	13	13
D14	12	12
D13	11	11
D12	10	10
D11	9	9
D10	8	8
D9	7	7
D8	6	6
D7	5	5
D6	4	4
D3	3	3
D2	2	2
D1	1	1
D0	0	0

SYNCHRONIZATION OF MULTIPLE DEVICES

OVERVIEW

The internal clocks of the AD9957 provide the timing for the propagation of data along the baseband signal processing path. These internal clocks are derived from the internal system clock (SYSCLK) and are all submultiples of the SYSCLK frequency. The logic state of all of these clocks in aggregate during any given SYSCLK cycle defines a unique clock state. The clock state advances with each cycle of SYSCLK, but the sequence of clock states is periodic. By definition, multiple devices are synchronized when their clock states match and they transition between states simultaneously. Clock synchronization allows the user to asynchronously program multiple devices, but synchronously activate the programming by applying a coincident I/O update to all devices. It also allows multiple devices to operate in unison when the parallel port is in use with either the QDUC or interpolating DAC mode (see Figure 59) or when the dual serial port (Blackfin interface) is in use.

The function of the synchronization logic in the AD9957 is to force the internal clock generator to a predefined state coincident with an external synchronization signal applied to the SYNC_IN pins. Forcing multiple devices to the same clock state coincident with the same external signal is, by definition, synchronization. Figure 54 is a block diagram of the synchronization function. The synchronization logic consists of two independent blocks, a sync generator and a sync receiver, both of which use the local SYSCLK signal for internal timing.

The synchronization mechanism relies on the premise that the REFCLK signal appearing at each device is edge aligned with all others resulting from the external REFCLK distribution system (see Figure 59).

CLOCK GENERATOR

The clock generator provides the necessary timing for the internal workings of the AD9957. The goal of the synchronization mechanism is to force the clock generator to a known state coincident with an external synchronization signal. The clock generator consists of three separate clock trees (see Figure 55). The first is a common clock generator that is active for all programmed modes of operation (single tone, QDUC, or interpolating DAC). The common clock generates the SYNC_CLK signal that appears at Pin 55. The second clock generator is active when the device is programmed for the interpolating DAC mode or quadrature modulation mode using the parallel data port. It uses the SYSCLK/2 output of the common clock as its primary timing source. The third clock generator is active when the device is programmed for quadrature modulation mode using the Blackfin interface.
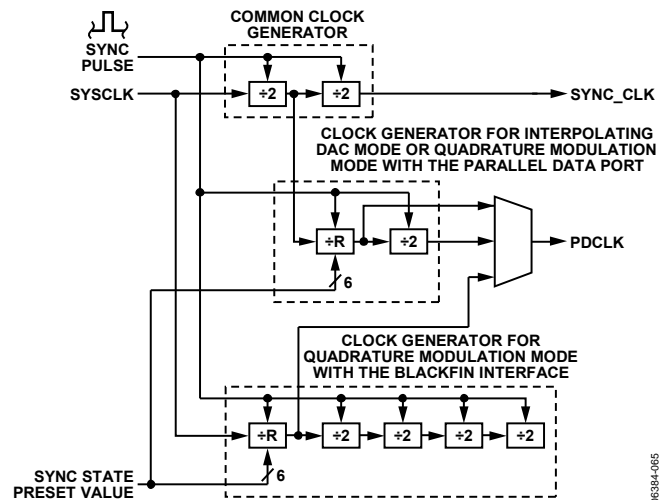
Figure 55. Clock Generator

SYNC GENERATOR

The sync generator block is shown in Figure 56. It is activated via the Sync Generator Enable bit. It allows for one AD9957 in a group to function as a master timing source with the remaining devices slaved to the master.

Figure 54. Synchronization Circuit Block Diagram
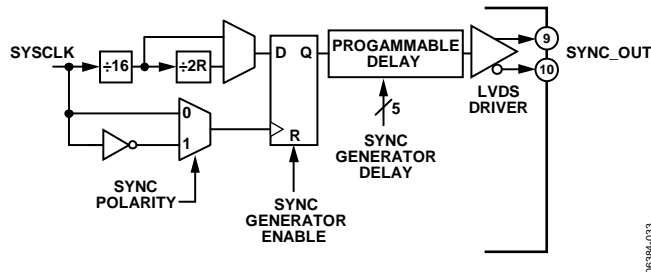
Figure 56. Sync Generator

The sync generator produces an LVDS-compatible clock signal with a 50% duty cycle that appears at the SYNC_OUT pins. The frequency of the SYNC_OUT signal can be one of two possible rates. With the AD9957 programmed for any of the following modes:

- Single tone mode
- Quadrature modulation mode with the CCI filter bypassed (that is, interpolation factor is 1)
- Interpolating DAC mode with the CCI filter bypassed (that is, interpolation factor is 1)

The frequency of SYNC_OUT is given by:

$$f_{SYNC\_OUT} = \frac{f_{SYSCLK}}{16}$$

With the AD9957 programmed for the QDUC or interpolating DAC mode and with the CCI filter not bypassed (that is, R>1) the frequency of SYNC_OUT is given by

$$f_{SYNC\_OUT} = \frac{f_{SYSCLK}}{32R}$$

where R is the programmed interpolation factor of the CCI filter.

The signal at the SYNC_OUT pins is edge aligned with either the rising or falling edge of the internal SYSCLK signal as determined by the Sync Polarity bit. Because the SYNC_OUT signal is synchronized with the internal SYSCLK of the master device, the master device SYSCLK serves as the reference timing source for all slave devices.

The user can adjust the output delay of the SYNC_OUT signal in steps of ~75 ps by programming the 5-bit sync generator delay word via the serial I/O port. The programmable output delay facilitates added edge timing flexibility to the overall synchronization mechanism.

SYNC RECEIVER

The sync receiver block (shown in Figure 57) is activated via the Sync Receiver Enable bit. The sync receiver consists of three subsections: the input delay and edge detection block, the internal clock generator block, and the setup-and-hold validation block.

The clock generator block remains operational even when the sync receiver is not enabled.

The sync receiver accepts an LVDS-compatible signal at the SYNC_IN pins. Typically, the signal applied to the SYNC_IN pins originates from the SYNC_OUT of another AD9957 functioning as a master timing unit. The sync receiver expects a periodic synchronization pulse that meets certain frequency requirements based on the operating mode of the AD9957. When programmed for single tone mode, the frequency of SYNC_IN must satisfy

$$f_{SYNC\_IN} = \frac{f_{SYSCLK}}{4M}$$

where M is any integer greater than zero. When programmed for quadrature modulation mode (using the parallel data port) or interpolating DAC mode, the frequency of SYNC_IN must satisfy

$$f_{SYNC\_IN} = \frac{f_{SYSCLK}}{16(R+M)}$$

where R is the programmed CCI interpolation factor and M is any integer greater than or equal to zero. When programmed for quadrature modulation mode using the Blackfin interface, the frequency of SYNC_IN must satisfy

$$f_{SYNC\_IN} = \frac{f_{SYSCLK}}{32(R+M)}$$

where R is the programmed CCI interpolation factor and M is any integer greater than or equal to zero.
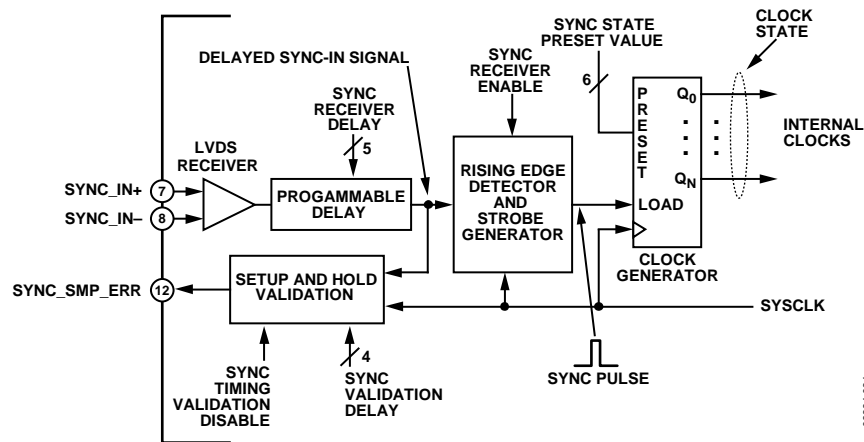
Figure 57. Sync Receiver

When a device other than another AD9957 provides the SYNC_IN signal it must be LVDS compatible. Furthermore, although SYNC_IN is typically considered to be a periodic clock signal, it is not an absolute requirement. It is feasible to drive the SYNC_IN pins with a single synchronization pulse as long as its edge transition meets the setup/hold timing required for the internally generated sync pulse (as detailed later in this section). However, using a periodic SYNC_IN signal has the distinct advantage that should any of the devices arbitrarily lose synchronization it automatically resynchronizes with the arrival of the next SYNC_IN edge.

The 5-bit sync receiver delay word in the multichip sync register delays the SYNC_IN signal in steps of ~75 ps. This provides the ability to time align the arrival of the SYNC_IN signal to multiple devices by compensating for unequal propagation times.

The edge detection logic in the sync receiver generates a synchronization pulse (sync pulse) having a duration of one SYSCLK cycle with a repetition rate equal to that of the signal applied to the SYNC_IN pins. To produce the sync pulse, the strobe generator samples the delayed rising edge of the SYNC_IN signal with the rising edge of the local SYSCLK. The generation of this sync pulse is crucial to the operation of the synchronization mechanism, because it performs the task of placing the clock generator into a known state. The sync pulse presets the R-divider stage of the internal clock generator, which behaves as a presettable downcounter (see Figure 55). The programmable 6-bit sync state preset value word in the multichip sync register establishes the preset state. The preset state is only active for a single SYSCLK period, after which the clock generator is free to cycle through its state sequence until the next sync pulse arrives (see Figure 55). In addition to presetting the R-divider, the sync pulse also synchronously presets the other dividers to a proper state in order to preserve the cadence of the clock tree.

The ability to program the clock state preset value provides the flexibility to synchronize devices, but with specific relative clock state offsets by assigning a different sync state preset value word

to each device in a group. This flexibility is limited, however, because the sync state preset value must adhere to certain bounds to satisfy internal timing requirements. Regardless of the programmed sync state preset value, the preset value is internally constrained to the range, 2 to R, where R is the CCI filter interpolation factor. A programmed value of 0 or 1 is forced to 2, whereas a programmed value greater than R is forced to R.

SETUP/HOLD VALIDATION

Synchronization of the AD9957 internal clock generator with other external devices relies on the ability of the sync receiver's edge detection circuit to generate a valid sync pulse. This requires proper sampling of the rising edge of the delayed SYNC_IN signal with the rising edge of the local SYSCLK. If the edge timing of these signals fails to meet the setup or hold time requirements of the internal latches in the edge detection circuitry, the proper generation of a sync pulse is in jeopardy. The setup-and-hold validation block (see Figure 58) gives the user a means to validate that proper edge timing exists between the two signals. The Sync Timing Validation Disable bit in Control Function Register 2 controls whether or not the setup-and-hold validation block is active.

The validation block makes use of a specified time window (programmable in increments of ~75 ps via the 4-bit sync validation delay word in the multichip sync register). The setup validation and hold validation circuits use latches identical to those in both the rising edge detector and strobe generator. The programmable time window skews the timing between the local SYSCLK signal and the delayed sync-in signal. If the hold validation and setup validation circuits fail to produce the same logic states, it is an indication of a possible setup or hold violation. The check logic of Figure 58 monitors the state of the setup and hold validation latches. If they are not equal (that is, a potential setup/hold violation exists), a Logic 1 is stored in an internal validation result latch; otherwise, a Logic 0 is stored. The state of validation result latch appears at the SYNC_SMP_ERR pin.

The validation result latch is in a reset state whenever the sync receiver is disabled, which forces the SYNC_SMP_ERR pin to a

Logic 0 state. To reset the validation result latch when the sync receiver is active, however, requires the use of the Sync Timing Validation Disable bit in the multichip sync register. To make a setup/hold validation measurement is a two-step process. First, write a Logic 1 to the sync timing validation disable bit. Then, to make a measurement, write a Logic 0. The first action resets the validation result latch and holds it in a reset state; the second action releases the reset state and enables the validation result latch to capture a setup/hold validation measurement. Each time a new setup/hold validation check is desired, this two-step procedure must be performed.

Because the programmed value of the sync validation delay establishes the time window for a setup/hold measurement,

the amount of delay is an important consideration for proper operation of the validation block. The value chosen should represent a small fraction of the SYSCLK period. For example, if the SYSCLK frequency is 1 GHz (1000 ps period), then a reasonable sync validation delay value is 4 (~300 ps). This allows the validation block to ensure that the local SYSCLK and the delayed SYNC_IN edges exhibit at least 300 ps of timing separation. Choosing too large a value can cause the validation block to indicate a setup/hold violation when one does not exist. Choosing too small a value can cause the validation block to miss a setup/hold violation when one actually exists.
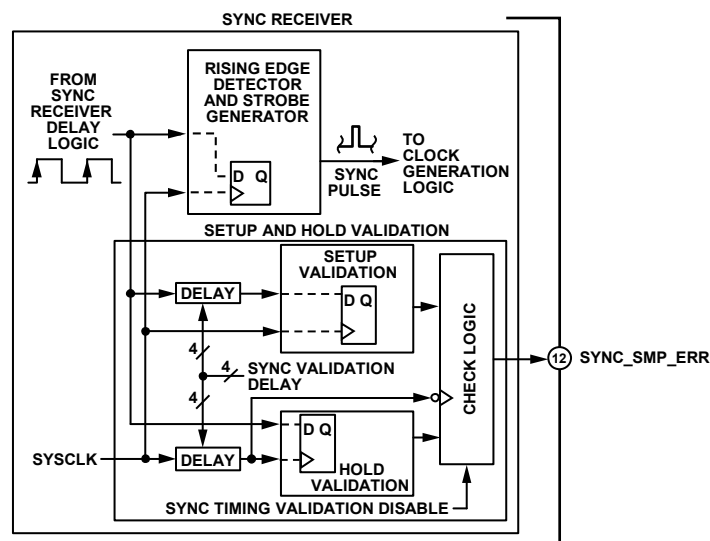
Figure 58. Sync Timing Validation Block

SYNCHRONIZATION EXAMPLE

To accomplish the synchronization of multiple devices provide each AD9957 with a SYNC_IN signal that is edge aligned across all the devices. If the SYNC_IN signal is edge aligned at all devices, and all devices have the same sync receiver delay and sync state preset value, then they all have matching clock states (that is, they are synchronized). Figure 59 shows this concept with three AD9957s in synchronization. One device operates as a master timing unit with the others synchronized to the master.

The master device must have its SYNC_IN pins included as part of the synchronization distribution and delay equalization mechanism. This ensures that the master maintains synchronous timing with the other units.

The synchronization mechanism begins with the clock distribution and delay equalization block, which ensures that all devices receive an edge-aligned REFCLK signal. However, even though the REFCLK signal is edge aligned among all devices, this alone does not guarantee that the clock state of each internal clock

generator is coordinated with the others. This is the role of the synchronization and delay equalization block. This block accepts the SYNC_OUT signal generated by the master device and redistributes it to the SYNC_IN input of the slave units (as well as feeding it back to the master). The goal of the redistributed SYNC_OUT signal from the master device is to deliver an edge-aligned SYNC_IN signal to all of the sync receivers.

Assuming that all devices share the same REFCLK edge timing (due to the clock distribution and delay equalization block) and that all devices share the same SYNC_IN edge timing (due to the synchronization and delay equalization block), then all devices should be generating an internal sync pulse in unison (assuming all have the same value for the sync receiver delay). With the further stipulation that all devices have the same sync state preset value, then the synchronized sync pulses cause all of the devices to assume the same predefined clock state simultaneously. That is, all devices have their internal clocks fully synchronized.
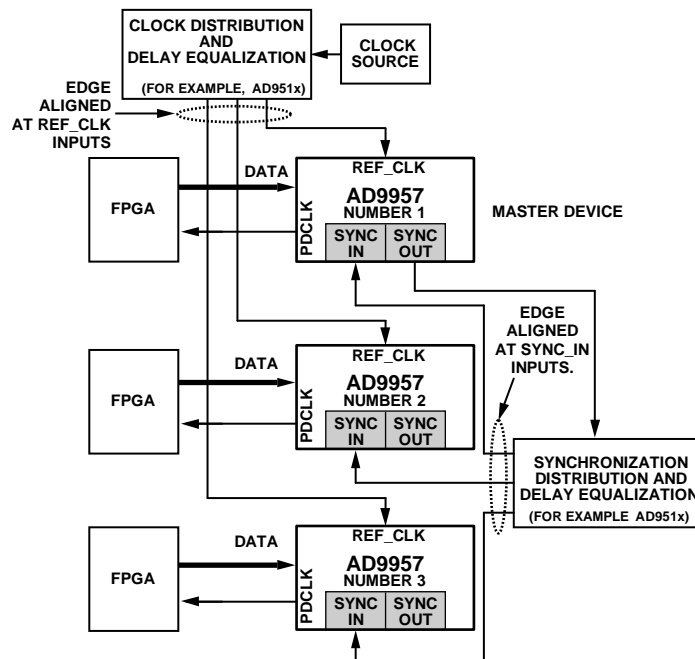
Figure 59. Multichip Synchronization Example

I/Q PATH LATENCY

The I/Q latency through the AD9957 is easiest to describe in terms of system clock (SYSCLK) cycles and is a function of the AD9957 configuration (that is, which mode and which optional features are engaged). The I/Q latency is primarily affected by the programmable CCI rate.

The values in Table 12 should be considered estimates because observed latency may be data dependent. The latency was calculated using the linear delay model for FIR filters. N = CCI rate (programmable interpolation rate, 2 to 63, 1 if bypassed).

In BFI mode, the latency through the AD9957 may not be constant for multiple transmissions. This is due to the relationship between the phase of the clock that drives the first half-band filter and the frame sync signal coming from the Blackfin, which is unknown and denoted as x in Table 12. The design successfully transfers data from the data assembler logic to the

signal process path by updating a parallel register at the proper time. The data is transferred from the parallel register to the signal processing chain and all timing has been verified regardless of the phase relationship between the updating of the parallel register and the signal processing clock.

Example

Quadrature modulation mode = 18-bit parallel data
Reference clock multiplier = bypassed
Input scale multiplier = off
Inverse CCI = off
CCI rate = 20
Inverse SINC = on
Output scale = off

$$Latency = (16 \times 20) + (4 \times 20) + (4 \times 20) + (69 \times 20) +$$
$$(4 \times 20 + 8) + 22 + 8 + 2 + 8 = 1988 \text{ SYSCLKs}$$

Table 12.

Stage	Quadrature Modulation Mode—Parallel	Quadrature Modulation Mode—BFI	Interpolation DAC Mode
Input Demuxplexer	16N	(16 + x)N where x = 0 to 15	28N
Input Scale Multiplier	Active: 8N Bypassed: 4N	Not available in BFI mode	Active: 8N Bypassed: 4N
Inverse CCI Filter	Active: 8N Bypassed: 4N	Active: 8N Bypassed: 4N	Active: 8N Bypassed: 4N
Half-Band Filters	69N	345N	69N
CCI Filter	Active: 4N + 8 Bypass: 2N + 4	Active: 4N + 8 Bypass: 2N + 4	Active: 4N + 8 Bypass: 2N + 4
Modulator	22	22	0
Inverse Sinc Filter	Active: 8 Bypass: 2	Active: 8 Bypass: 2	Active: 8 Bypass: 2
Output Scale Multiplier	Active: 12 Bypass: 2	Active: 12 Bypass: 2	Active: 12 Bypass: 2
DAC Interface	8	8	8

POWER SUPPLY PARTITIONING

The AD9957 features multiple power supplies, and their power consumption varies with its configuration. This section covers which power supplies can be grouped together and how the power consumption of each block varies with frequency.

The values quoted in this section are for comparison only. Refer to Table 1 for exact values. With each group, bypass capacitors of 1 μF in parallel with a 10 μF capacitor should be used.

The recommendations here are for typical applications, for which there are four groups of power supplies: 3.3 V digital, 3.3 V analog, 1.8 V digital, and 1.8 V analog.

Applications demanding the highest performance may require additional power supply isolation.

3.3 V SUPPLIES

DVDD_I/O (Pin 11, Pin 15, Pin 21, Pin 28, Pin 45, Pin 56, Pin 66)

These 3.3 V supplies can be grouped together. The power consumption on these pins varies dynamically with serial port activity.

AVDD (Pin 74 to Pin 77 and Pin 83)

These are 3.3 V DAC power supplies that typically consume about 28 mA. At a minimum, a ferrite bead should be used to isolate these from other 3.3 V supplies, with a separate regulator being ideal. The current consumption of these supplies consist mainly of biasing current and do not vary with frequency.

1.8 V SUPPLIES

DVDD (Pin 17, Pin 23, Pin 30, Pin 47, Pin 57, Pin 64)

These pins can be grouped together. Their current consumption increases linearly with the system clock frequency. A system clock of 1 GHz produces a typically current consumption of 610 mA in QDUC mode. There is also a slight (~5%) increase as f_{OUT} increases from 50 MHz to 400 MHz.

AVDD (Pin 3)

This 1.8 V supply powers the REFCLK multiplier (PLL) and consumes about 7 mA. For applications demanding the highest performance with the PLL enabled, this supply should be isolated from other 1.8 V AVDD supplies with a separate regulator. For less demanding applications this supply can be run off the same regulator as Pin 89, Pin 92 with a ferrite bead to isolate Pin 3 from Pin 89, and Pin 89.

The loop filter for the PLL should directly connect to Pin 3. If the PLL is bypassed, pin 3 should still be powered, but isolation is not critical.

AVDD (Pin 6)

This pin can be grouped together with the DVDD 1.8V supply pins. For the highest performance, a ferrite bead should be used for isolation, with a separate regulator being ideal.

AVDD (Pin 89 and Pin 92)

This 1.8 V supply for the REFCLK input consumes about 15 mA. The supply can be run off the same as Pin 3 with a ferrite bead to isolate Pin 3 from Pin 89 and Pin 92. At a minimum, a ferrite bead should be used to isolate these from other 1.8 V supplies. However, for applications demanding the highest performance, a separate regulator is recommended.

SERIAL PROGRAMMING

CONTROL INTERFACE—SERIAL I/O

The AD9957 serial port is a flexible, synchronous serial communications port allowing easy interface to many industry-standard microcontrollers and microprocessors.

The interface allows read/write access to all registers that configure the AD9957. MSB-first or LSB-first transfer formats are supported. In addition, the serial interface port can be configured as a single pin input/output (SDIO) allowing a two-wire interface, or it can be configured as two unidirectional pins for input/output (SDIO/SDO), enabling a 3-wire interface. Two optional pins (I/O_RESET and $\overline{CS}$) enable greater flexibility for designing systems with the AD9957.

GENERAL SERIAL I/O OPERATION

There are two phases to a serial communications cycle. The first is the instruction phase to write the instruction byte into the AD9957. The instruction byte contains the address of the register to be accessed (see the Register Map and Bit Descriptions section) and defines whether the upcoming data transfer is a write or read operation.

For a write cycle, Phase 2 represents the data transfer between the serial port controller to the serial port buffer. The number of bytes transferred is a function of the register being accessed. For example, when accessing the Control Function Register 2 (Address 0x01), Phase 2 requires that four bytes be transferred. Each bit of data is registered on each corresponding rising edge of SCLK. The serial port controller expects that all bytes of the register be accessed; otherwise, the serial port controller is put out of sequence for the next communication cycle. However, one way to write fewer bytes than required is to use the I/O_RESET pin feature. The I/O_RESET pin function can be used to abort an I/O operation and reset the pointer of the serial port controller. After an I/O reset, the next byte is the instruction byte. Note that every completed byte written prior to an I/O reset is preserved in the serial port buffer. Partial bytes written are not preserved. At the completion of any communication cycle, the AD9957 serial port controller expects the next eight rising SCLK edges to be the instruction byte for the next communication cycle.

After a write cycle, the programmed data resides in the serial port buffer and is inactive. I/O_UPDATE transfers data from the serial port buffer to active registers. The I/O update can either be sent after each communication cycle or when all serial operations are complete. In addition, a change in profile pins can initiate an I/O update.

For a read cycle, Phase 2 is the same as the write cycle with the following differences: Data is read from the active registers, not the serial port buffer, and data is driven out on the falling edge of SCLK.

Note that to read back any profile register (0x0E to 0x15), the three external profile pins must be used. For example, if the profile register is Profile 5 (0x13) then PROFILE<0:2> pins must equal 101.This is not required to write to profile registers.

INSTRUCTION BYTE

The instruction byte contains the following information as shown in the instruction byte bit map.

Instruction Byte Information Bit Map

MSB							LSB
D7	D6	D5	D4	D3	D2	D1	D0
R/$\overline{W}$	X	X	A4	A3	A2	A1	A0

R/$\overline{W}$—Bit 7 of the instruction byte determines whether a read or write data transfer occurs after the instruction byte write. Logic 1 indicates a read operation. Cleared indicates a write operation.

X, X—Bit 6 and Bit 5 of the instruction byte are don't cares.

A4, A3, A2, A1, A0—Bit 4, Bit 3, Bit 2, Bit 1, and Bit 0 of the instruction byte determine which register is accessed during the data transfer portion of the communications cycle.

SERIAL I/O PORT PIN DESCRIPTIONS

SCLK—Serial Clock

The serial clock pin is used to synchronize data to and from the AD9957 and to run the internal state machines.

$\overline{CS}$—Chip Select Bar

An active low input that allows more than one device on the same serial communications line. The SDO and SDIO pins go to a high impedance state when this input is high. If driven high during any communications cycle, that cycle is suspended until $\overline{CS}$ is reactivated low. Chip select ($\overline{CS}$) can be tied low in systems that maintain control of SCLK.

SDIO—Serial Data Input/Output

Data is always written into the AD9957 on this pin. However, this pin can be used as a bidirectional data line. Bit 1 of CFR1, Register Address 0x00, controls the configuration of this pin. The default is cleared, which configures the SDIO pin as bidirectional.

SDO—Serial Data Out

Data is read from this pin for protocols that use separate lines for transmitting and receiving data. In the case where the AD9957 operates in a single bidirectional I/O mode, this pin does not output data and is set to a high impedance state.

I/O_RESET—Input/Output Reset

I/O_RESET synchronizes the I/O port state machines without affecting the addressable registers contents. An active high input on the I/O_RESET pin causes the current communication cycle to abort. After I/O_RESET returns low (Logic 0), another communication cycle can begin, starting with the instruction byte write.

I/O_UPDATE—Input/Output Update

The I/O_UPDATE initiates the transfer of written data from the I/O port buffer to active registers. I/O_UPDATE is active on the rising edge and its pulse width must be greater than one SYNC_CLK period. It is either an input or output pin depending on the programming of the Internal I/O Update Active bit.

SERIAL I/O TIMING DIAGRAMS

Figure 60 through Figure 63 provide basic examples of the timing relationships between the various control signals of the serial I/O port. Most of the bits in the register map are not transferred to their internal destinations until assertion of an I/O update, which is not included in the timing diagrams that follow.

MSB/LSB TRANSFERS

The AD9957 serial port can support both most significant bit (MSB) first or least significant bit (LSB) first data formats. This functionality is controlled by Bit 0 in Control Function Register 1 (0x00). The default format is MSB first. If LSB first is active, all data, including the instruction byte, must follow LSB-first convention. Note that the highest number found in the bit range column for each register is the MSB and the lowest number is the LSB for that register (see the Register Map and Bit Descriptions section and Table 13).
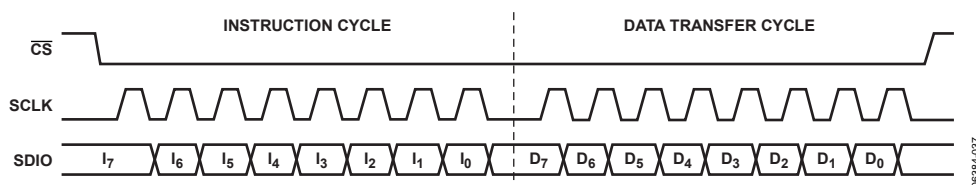
Figure 60. Serial Port Write Timing—Clock Stall Low
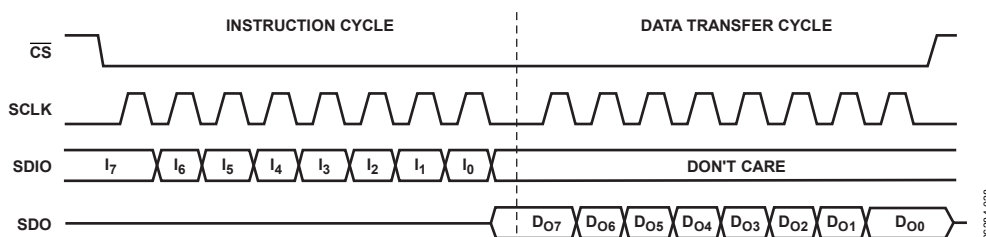
Figure 61. 3-Wire Serial Port Read Timing—Clock Stall Low
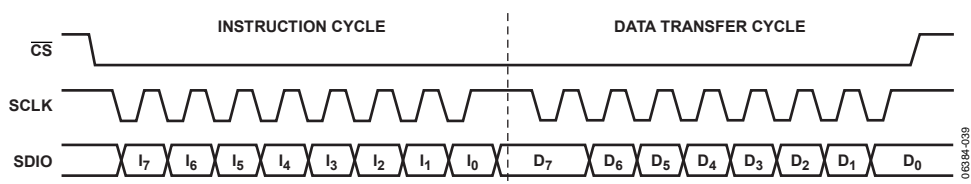
Figure 62. Serial Port Write Timing—Clock Stall High
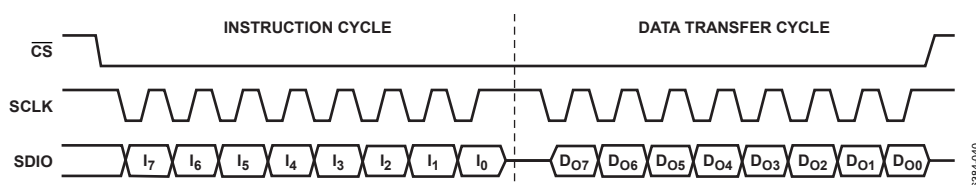
Figure 63. 2-Wire Serial Port Read Timing—Clock Stall High

I/O_UPDATE, SYNC_CLK, AND SYSTEM CLOCK RELATIONSHIPS

The I/O_UPDATE pin is used to transfer data from the serial I/O buffer to the active registers in the device. Data in the buffer is inactive.

SYNC_CLK is a rising edge active signal. It is derived from the system clock and a divide-by-4 frequency divider. SYNC_CLK, which is externally provided, can be used to synchronize external hardware to the AD9957 internal clocks.

I/O_UPDATE initiates the start of a buffer transfer. It can be sent synchronously or asynchronously relative to the SYNC_CLK. If the setup time between these signals is met, then constant latency (pipeline) to the DAC output exists.

For example, if repetitive changes to phase offset via the SPI port is desired, the latency of those changes to the DAC output is constant; otherwise, a time uncertainty of one SYNC_CLK period is present.

By default, the I/O_UPDATE pin is an input that serves as a strobe signal to allow synchronous update of the device operating parameters. A rising edge on I/O_UPDATE initiates transfer of the register contents to the internal workings of the device. Alternatively, the transfer of programmed data from the programming registers to the internal hardware can be accomplished by changing the state of the PROFILE[2:0] pins.

The timing diagram shown in Figure 64 depicts when the data in the buffer is transferred to the active registers.
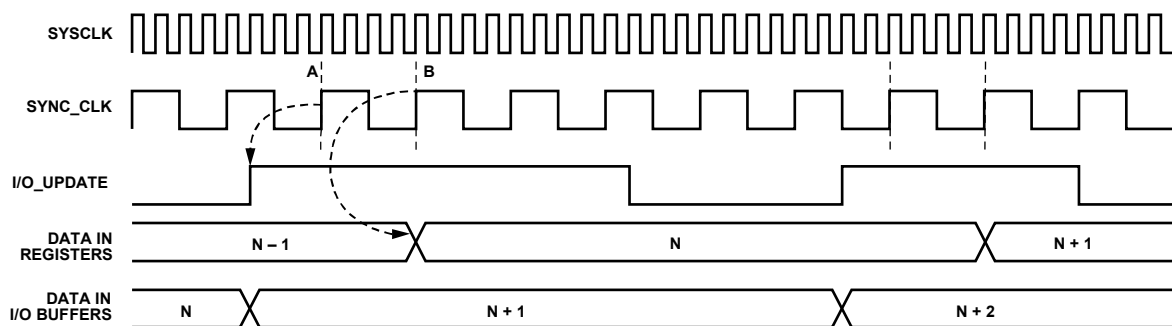
THE DEVICE REGISTERS AN I/O UPDATE AT POINT A. THE DATA IS TRANSFERRED FROM THE ASYNCHRONOUSLY LOADED I/O BUFFERS AT POINT B.

Figure 64. I/O_UPDATE Transferring Data from I/O Buffer to Active Registers

REGISTER MAP AND BIT DESCRIPTIONS

REGISTER MAP

Note that the highest number found in the Bit Range column for each register in the following tables is the MSB and the lowest number is the LSB for that register.

Table 13. Control Registers

Register Name (Serial Address)	Bit Range (Internal Address)	Bit 7 (MSB)	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0 (LSB)	Default Value
Control Function Register 1 CFR1 (0x00)	<31:24>	RAM Enable	Open		RAM Playback Destination	Open		Operating Mode		0x00
	<23:16>	Manual OSK External Control	Inverse Sinc Filter Enable	Clear CCI	Open				Select DDS Sine Output	0x00
	<15:8>	Open		Autoclear Phase Accumulator	Open	Clear Phase Accumulator	Load ARR @ I/O Update	OSK Enable	Select Auto-OSK	0x00
	<7:0>	Digital Power-Down	DAC Power-Down	REFCLK Input Power-Down	Aux DAC Power-Down	External Power-Down Control	Auto Power-Down Enable	SDIO Input Only	LSB First	0x00
Control Function Register 2 CFR2 (0x01)	<31:24>	Blackfin Interface Mode Active	Blackfin Bit Order	Blackfin Early Frame Sync Enable	Open				Enable Profile Registers as ASF Source	0x00
	<23:16>	Internal I/O Update Active	SYNC_CLK Enable	Open					Read Effective FTW	0x40
	<15:8>	I/O Update Rate Control		PDCLK Rate Control	Data Format	PDCLK Enable	PDCLK Invert	TxEnable Invert	Q-First Data Pairing	0x08
	<7:0>	Open	Data Assembler Hold Last Value	Sync Timing Validation Disable	Open					0x20
Control Function Register 3 CFR3 (0x02)	<31:24>	Open		DRV0<1:0>		Open	VCO SEL<2:0>			0x1F
	<23:16>	Open		I_{CP}<2:0>			Open			0x3F
	<15:8>	REFCLK Input Divider Bypass	REFCLK Input Divider ResetB	Open					PLL Enable	0x40
	<7:0>	N<6:0>							Open	0x00
Auxiliary DAC Control Register (0x03)	<31:24>	Open								0x00
	<23:16>	Open								0x00
	<15:8>	Open								0x7F
	<7:0>	FSC<7:0>								0x7F
I/O Update Rate Register (0x04)	<31:24>	I/O Update Rate<31:24>								0xFF
	<23:16>	I/O Update Rate<23:16>								0xFF
	<15:8>	I/O Update Rate<15:8>								0xFF
	<7:0>	I/O Update Rate<7:0>								0xFF

Table 14. RAM, ASF, Multichip Sync, and Profile 0 Registers

Register Name (Serial Address)	Bit Range (Internal Address)	Bit 7 (MSB)	Bit 6	Bit5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0 (LSB)	Default Value
RAM Segment Register 0 (0x05)	<47:40>	RAM Address Step Rate 0<15:8>								
	<39:32>	RAM Address Step Rate 0<7:0>								
	<31:24>	RAM End Address 0<9:2>								
	<23:16>	RAM End Address 0<1:0>	Open							
	<15:8>	RAM Start Address 0<9:2>								
	<7:0>	RAM Start Address 0<1:0>	Open			RAM Playback Mode 0<2:0>				
RAM Segment Register 1 (0x06)	<47:40>	RAM Address Step Rate 1<15:8>								
	<39:32>	RAM Address Step Rate 1<7:0>								
	<31:24>	RAM End Address 1<9:2>								
	<23:16>	RAM End Address 1<1:0>	Open							
	<15:8>	RAM Start Address 1<9:2>								
	<7:0>	RAM Start Address 1<1:0>	Open			RAM Playback Mode 1<2:0>				
Amplitude Scale Factor (ASF) Register (0x09)	<31:24>	Amplitude Ramp Rate<15:8>								0x00
	<23:16>	Amplitude Ramp Rate<7:0>								0x00
	<15:8>	Amplitude Scale Factor<13:6>								0x00
	<7:0>	Amplitude Scale Factor<5:0>						Amplitude Step Size<1:0>		0x00
Multichip Sync Register (0x0A)	<31:24>	Sync Validation Delay<3:0>				Sync Receiver Enable	Sync Generator Enable	Sync Generator Polarity	Open	0x00
	<23:16>	Sync State Preset Value<5:0>						Open		0x00
	<15:8>	Sync Generator Delay<4:0>					Open			0x00
	<7:0>	Sync Receiver Delay<4:0>					Open			0x00
Profile 0 Register—Single Tone (0x0E)	<63:56>	Open		Amplitude Scale Factor<13:8>						0x08
	<55:48>	Amplitude Scale Factor<7:0>								0xB5
	<47:40>	Phase Offset Word<15:8>								0x00
	<39:32>	Phase Offset Word<7:0>								0x00
	<31:24>	Frequency Tuning Word<31:24>								0x00
	<23:16>	Frequency Tuning Word<23:16>								0x00
	<15:8>	Frequency Tuning Word<15:8>								0x00
	<7:0>	Frequency Tuning Word<7:0>								0x00
Profile 0 Register—QDUC (0x0E)	<63:56>	CCI Interpolation Rate<7:2>						Spectral Invert	Inverse CCI Bypass	0x00
	<55:48>	Output Scale Factor								0x00
	<47:40>	Phase Offset Word<15:8>								0x00
	<39:32>	Phase Offset Word<7:0>								0x00
	<31:24>	Frequency Tuning Word<31:24>								0x00
	<23:16>	Frequency Tuning Word<23:16>								0x00
	<15:8>	Frequency Tuning Word<15:8>								0x00
	<7:0>	Frequency Tuning Word<7:0>								0x00

Table 15. Profile 1, Profile 2, and Profile 3 Registers

Register Name (Serial Address)	Bit Range (Internal Address)	Bit 7 (MSB)	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0 (LSB)	Default Value
Profile 1 Register—Single Tone (0x0F)	<63:56>	Open		Amplitude Scale Factor<13:8>						0x00
	<55:48>	Amplitude Scale Factor<7:0>								0x00
	<47:40>	Phase Offset Word<15:8>								0x00
	<39:32>	Phase Offset Word<7:0>								0x00
	<31:24>	Frequency Tuning Word<31:24>								0x00
	<23:16>	Frequency Tuning Word<23:16>								0x00
	<15:8>	Frequency Tuning Word<15:8>								0x00
	<7:0>	Frequency Tuning Word<7:0>								0x00
Profile 1 Register—QDUC (0x0F)	<63:56>	CCI Interpolation Rate<7:2>						Spectral Invert	Inverse CCI Bypass	0x00
	<55:48>	Output Scale Factor<7:0>								0x00
	<47:40>	Phase Offset Word<15:8>								0x00
	<39:32>	Phase Offset Word<7:0>								0x00
	<31:24>	Frequency Tuning Word<31:24>								0x00
	<23:16>	Frequency Tuning Word<23:16>								0x00
	<15:8>	Frequency Tuning Word<15:8>								0x00
	<7:0>	Frequency Tuning Word<7:0>								0x00
Profile 2 Register—Single Tone (0x10)	<63:56>	Open		Amplitude Scale Factor<13:8>						0x00
	<55:48>	Amplitude Scale Factor<7:0>								0x00
	<47:40>	Phase Offset Word<15:8>								0x00
	<39:32>	Phase Offset Word<7:0>								0x00
	<31:24>	Frequency Tuning Word<31:24>								0x00
	<23:16>	Frequency Tuning Word<23:16>								0x00
	<15:8>	Frequency Tuning Word<15:8>								0x00
	<7:0>	Frequency Tuning Word<7:0>								0x00
Profile 2 Register—QDUC (0x10)	<63:56>	CCI Interpolation Rate<7:2>						Spectral Invert	Inverse CCI Bypass	0x00
	<55:48>	Output Scale Factor<7:0>								0x00
	<47:40>	Phase Offset Word<15:8>								0x00
	<39:32>	Phase Offset Word<7:0>								0x00
	<31:24>	Frequency Tuning Word<31:24>								0x00
	<23:16>	Frequency Tuning Word<23:16>								0x00
	<15:8>	Frequency Tuning Word<15:8>								0x00
	<7:0>	Frequency Tuning Word<7:0>								0x00
Profile 3 Register—Single Tone (0x11)	<63:56>	Open		Amplitude Scale Factor<13:8>						0x00
	<55:48>	Amplitude Scale Factor<7:0>								0x00
	<47:40>	Phase Offset Word<15:8>								0x00
	<39:32>	Phase Offset Word<7:0>								0x00
	<31:24>	Frequency Tuning Word<31:24>								0x00
	<23:16>	Frequency Tuning Word<23:16>								0x00
	<15:8>	Frequency Tuning Word<15:8>								0x00
	<7:0>	Frequency Tuning Word<7:0>								0x00
Profile 3 Register—QDUC (0x11)	<63:56>	CCI Interpolation Rate<7:2>						Spectral Invert	Inverse CCI Bypass	0x00
	<55:48>	Output Scale Factor<7:0>								0x00
	<47:40>	Phase Offset Word<15:8>								0x00
	<39:32>	Phase Offset Word<7:0>								0x00
	<31:24>	Frequency Tuning Word<31:24>								0x00
	<23:16>	Frequency Tuning Word<23:16>								0x00
	<15:8>	Frequency Tuning Word<15:8>								0x00
	<7:0>	Frequency Tuning Word<7:0>								0x00

Table 16. Profile 4, Profile 5, and Profile 6 Registers

Register Name (Serial Address)	Bit Range (Internal Address)	Bit 7 (MSB)	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0 (LSB)	Default Value
Profile 4 Register—Single Tone (0x12)	<63:56>	Open			Amplitude Scale Factor<13:8>					0x00
	<55:48>	Amplitude Scale Factor<7:0>								0x00
	<47:40>	Phase Offset Word<15:8>								0x00
	<39:32>	Phase Offset Word<7:0>								0x00
	<31:24>	Frequency Tuning Word<31:24>								0x00
	<23:16>	Frequency Tuning Word<23:16>								0x00
	<15:8>	Frequency Tuning Word<15:8>								0x00
	<7:0>	Frequency Tuning Word<7:0>								0x00
Profile 4 Register—QDUC (0x12)	<63:56>	CCI Interpolation Rate<7:2>						Spectral Invert	Inverse CCI Bypass	0x00
	<55:48>	Output Scale Factor<7:0>								0x00
	<47:40>	Phase Offset Word<15:8>								0x00
	<39:32>	Phase Offset Word<7:0>								0x00
	<31:24>	Frequency Tuning Word<31:24>								0x00
	<23:16>	Frequency Tuning Word<23:16>								0x00
	<15:8>	Frequency Tuning Word<15:8>								0x00
	<7:0>	Frequency Tuning Word<7:0>								0x00
Profile 5 Register—Single Tone (0x13)	<63:56>	Open			Amplitude Scale Factor<13:8>					0x00
	<55:48>	Amplitude Scale Factor<7:0>								0x00
	<47:40>	Phase Offset Word<15:8>								0x00
	<39:32>	Phase Offset Word<7:0>								0x00
	<31:24>	Frequency Tuning Word<31:24>								0x00
	<23:16>	Frequency Tuning Word<23:16>								0x00
	<15:8>	Frequency Tuning Word<15:8>								0x00
	<7:0>	Frequency Tuning Word<7:0>								0x00
Profile 5 Register—QDUC (0x13)	<63:56>	CCI Interpolation Rate<7:2>						Spectral Invert	Inverse CCI Bypass	0x00
	<55:48>	Output Scale Factor<7:0>								0x00
	<47:40>	Phase Offset Word<15:8>								0x00
	<39:32>	Phase Offset Word<7:0>								0x00
	<31:24>	Frequency Tuning Word<31:24>								0x00
	<23:16>	Frequency Tuning Word<23:16>								0x00
	<15:8>	Frequency Tuning Word<15:8>								0x00
	<7:0>	Frequency Tuning Word<7:0>								0x00
Profile 6 Register—Single Tone (0x14)	<63:56>	Open			Amplitude Scale Factor<13:8>					0x00
	<55:48>	Amplitude Scale Factor<7:0>								0x00
	<47:40>	Phase Offset Word<15:8>								0x00
	<39:32>	Phase Offset Word<7:0>								0x00
	<31:24>	Frequency Tuning Word<31:24>								0x00
	<23:16>	Frequency Tuning Word<23:16>								0x00
	<15:8>	Frequency Tuning Word<15:8>								0x00
	<7:0>	Frequency Tuning Word<7:0>								0x00
Profile 6 Register—QDUC (0x14)	<63:56>	CCI Interpolation Rate<7:2>						Spectral Invert	Inverse CCI Bypass	0x00
	<55:48>	Output Scale Factor<7:0>								0x00
	<47:40>	Phase Offset Word<15:8>								0x00
	<39:32>	Phase Offset Word<7:0>								0x00
	<31:24>	Frequency Tuning Word<31:24>								0x00
	<23:16>	Frequency Tuning Word<23:16>								0x00
	<15:8>	Frequency Tuning Word<15:8>								0x00
	<7:0>	Frequency Tuning Word<7:0>								0x00

Table 17. Profile 7, RAM, GPIO Configuration, and GPIO Data Registers

Register Name (Serial Address)	Bit Range (Internal Address)	Bit 7 (MSB)	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0 (LSB)	Default Value
Profile 7 Register— Single Tone (0x15)	<63:56>	Open		Amplitude Scale Factor<13:8>						0x00
	<55:48>	Amplitude Scale Factor<7:0>								0x00
	<47:40>	Phase Offset Word<15:8>								0x00
	<39:32>	Phase Offset Word<7:0>								0x00
	<31:24>	Frequency Tuning Word<31:24>								0x00
	<23:16>	Frequency Tuning Word<23:16>								0x00
	<15:8>	Frequency Tuning Word<15:8>								0x00
	<7:0>	Frequency Tuning Word<7:0>								0x00
Profile 7 Register— QDUC (0x15)	<63:56>	CCI Interpolation Rate<7:2>						Spectral Invert	Inverse CCI Bypass	0x00
	<55:48>	Output Scale Factor<7:0>								0x00
	<47:40>	Phase Offset Word<15:8>								0x00
	<39:32>	Phase Offset Word<7:0>								0x00
	<31:24>	Frequency Tuning Word<31:24>								0x00
	<23:16>	Frequency Tuning Word<23:16>								0x00
	<15:8>	Frequency Tuning Word<15:8>								0x00
	<7:0>	Frequency Tuning Word<7:0>								0x00
RAM Register (0x16)	<31:0>	RAM Word<31:0>								
GPIO Configuration Register (0x18)	<15:0>	GPIO Configuration<15:0>								0x00
GPIO Data Register (0x19)	<15:0>	GPIO Data<15:0>								0x00

REGISTER BIT DESCRIPTIONS

The serial I/O port registers span an address range of 0 to 25 (0x00 to 0x19 in hexadecimal notation). This represents a total of 26 registers. However, six of these registers are unused, yielding a total of 20 available registers. The unused registers are 7, 8, 11 to 13, and 23 (0x07 to 0x08, 0x0B to 0x0D, and 0x17).

The number of bytes assigned to the registers varies. That is, the registers are not of uniform depth; each contains the number of bytes necessary for its particular function. Additionally, the registers are assigned names according to their functionality. In some cases, a register is given a mnemonic descriptor. For example, the register at Serial Address 0x00 is named Control Function Register 1 and is assigned the mnemonic CFR1.

The following section provides a detailed description of each bit in the AD9957 register map. For cases in which a group of bits serve a specific function, the entire group is considered as a binary word and described in aggregate.

This section is organized in sequential order of the serial addresses of the registers. Following each subheading are the individual bit descriptions for that particular register. The location of the bit(s) in the register are indicated by <A> or <A:B>, where A and B are bit numbers. The notation, <A:B>, specifies a range of bits from most significant to least significant bit position. For example, <5:2> means bit positions 5 down to 2, inclusive, with Bit 0 identifying the LSB of the register.

Unless otherwise stated, programmed bits are not transferred to their internal destinations until the assertion of an I/O update or profile change.

Control Function Register 1 (CFR1)

Address 0x00, four bytes are assigned to this register.

Table 18. Bit Descriptions for CFR1 Register

Bit (s)	Mnemonic	Description
31	RAM Enable	0: disables RAM playback functionality (default).
		1: enables RAM playback functionality.
30:29	Open	
28	RAM Playback Destination	Ineffective unless CFR1<31> = 1.
		0: RAM playback data routed to baseband scaling multipliers (default).
		1: RAM playback data routed to baseband I/Q data path.
27:26	Open	
25:24	Operating Mode	00: quadrature modulation mode (default).
		01: single tone mode.
		1x: interpolating DAC mode.
23	Manual OSK External Control	Ineffective unless CFR1<9:8> = 10b.
		0: OSK pin inoperative (default).
		1: OSK pin enabled for manual OSK control (see the Output Shift Keying (OSK) section).
22	Inverse Sinc Filter Enable	0: inverse sinc filter bypassed (default).
		1: inverse sinc filter active.
21	Clear CCI	This bit is automatically cleared by the serial I/O port controller. This operation requires several internal clock cycles to complete, during which time the data supplied to the CCI input by the baseband signal chain is ignored. The inputs are forced to all zeros to flush the CCI data path, after which the CCI accumulators are reset.
		0: normal operation of the CCI filter (default).
		1: initiates an asynchronous reset of the accumulators in the CCI filter.
20:17	Open	
16	Select DDS Sine Output	Ineffective unless CFR1<25:24> = 01b.
		0: cosine output of the DDS is selected (default).
		1: sine output of the DDS is selected.
15:14	Open	
13	Autoclear Phase Accumulator	0: normal operation of the DDS phase accumulator (default).
		1: synchronously resets the DDS phase accumulator any time I/O_UPDATE is asserted or a profile change occurs.
12	Open	
11	Clear Phase Accumulator	0: normal operation of the DDS phase accumulator (default).
		1: asynchronous, static reset of the DDS phase accumulator.
10	Load ARR @ I/O Update	0: normal operation of the OSK amplitude ramp rate timer (default).
		1: OSK amplitude ramp rate timer reloaded any time I/O_UPDATE is asserted or a profile change occurs.

Bit (s)	Mnemonic	Description
9	OSK (Output Shift Keying) Enable	0: OSK disabled (default).
		1: OSK enabled.
8	Select Auto-OSK	Ineffective unless CFR1<9> = 1.
		0: manual OSK enabled (default).
		1: automatic OSK enabled.
7	Digital Power-Down	This bit is effective without the need for an I/O update.
		0: clock signals to the digital core are active (default).
		1: clock signals to the digital core are disabled.
6	DAC Power-Down	0: DAC clock signals and bias circuits are active (default).
		1: DAC clock signals and bias circuits are disabled.
5	REFCLK Input Power-Down	This bit is effective without the need for an I/O update.
		0: REFCLK input circuits and PLL are active (default).
		1: REFCLK input circuits and PLL are disabled.
4	Auxiliary DAC Power-Down	0: auxiliary DAC clock signals and bias circuits are active (default).
		1: auxiliary DAC clock signals and bias circuits are disabled.
3	External Power-Down Control	0: assertion of the EXT_PWR_DWN pin affects full power-down (default).
		1: assertion of the EXT_PWR_DWN pin affects fast recovery power-down.
2	Auto Power-Down Enable	Ineffective when CFR1<25:24> = 01b.
		0: disable power-down (default).
		1: when the TxEnable pin is Logic 0, the baseband signal processing chain is flushed of residual data and the clocks are automatically stopped. Clocks restart when the TxENABLE pin is a Logic 1.
1	SDIO Input Only	0: configures the SDIO pin for bidirectional operation; 2-wire serial programming mode (default).
		1: configures the serial data I/O pin (SDIO) as an input only pin; 3-wire serial programming mode.
0	LSB First	0: configures the serial I/O port for MSB first format (default).
		1: configures the serial I/O port for LSB first format.

Control Function Register 2 (CFR2)

Address 0x01, four bytes are assigned to this register.

Table 19. Bit Descriptions for CFR2 Register

Bit (s)	Mnemonic	Description
31	Blackfin Interface Mode Active	Valid only when CFR1<25:24> = 00b (quadrature modulation mode).
		0: Pin D<17:0> configured as an 18-bit parallel port (default).
		1: Pin D<5:4> configured as a dual serial port compatible with the Blackfin serial interface. Pin D<17:6> and Pin D<3:0> become available as a 16-bit GPIO port.
30	Blackfin Bit Order	Valid only when CFR2<31> = 1.
		0: the dual serial port (BFI) configured for MSB first operation (default).
		1: the dual serial port (BFI) configured for LSB first operation.
29	Blackfin Early Frame Sync Enable	Valid only when CFR2<31> = 1.
		0: the dual serial port (BFI) configured to be compatible with Blackfin late frame sync operation (default).
		1: the dual serial port (BFI) configured to be compatible with Blackfin early frame sync operation.
28:25	Open	
24	Enable Profile Registers as ASF Source	Valid only when CFR1<25:24> = 01b (single tone mode) and CFR1<9> = 0 (OSK disabled).
		0: amplitude scale factor bypassed (unity gain).
		1: the active profile register determines the amplitude scale factor.
23	Internal I/O Update Active	This bit is effective without the need for an I/O update.
		0: serial I/O programming is synchronized with external assertion of the I/O_UPDATE pin, which is configured as an input pin (default).
		1: serial I/O programming is synchronized with an internally generated I/O update signal (the internally generated signal appears at the I/O_UPDATE pin, which is configured as an output pin).
22	SYNC_CLK Enable	0: the SYNC_CLK pin is disabled; static Logic 0 output.
		1: the SYNC_CLK pin generates a clock signal at ¼ f_{SYSCLK}; use of synchronization of the serial I/O port (default).

Bit (s)	Mnemonic	Description
21:17	Open	
16	Read Effective FTW	0: a serial I/O port read operation of the FTW register reports the contents of the FTW register (default).
		1: a serial I/O port read operation of the FTW register reports the actual 32-bit word appearing at the input to the DDS phase accumulator.
15:14	I/O Update Rate Control	Ineffective unless CFR2<23> = 1. Sets the prescale ratio of the divider that clocks the I/O update timer as follows:
		00: divide-by-1 (default).
		01: divide-by-2.
		10: divide-by-4.
		11: divide-by-8.
13	PDCLK Rate Control	Ineffective unless CFR2<31> = 0 and CFR1<25:24> = 00b.
		0: PDCLK operates at the input data rate (default).
		1: PDCLK operates at ½ the input data rate; useful for maintaining a consistent relationship between I/Q words at the parallel data port and the internal clocks of the baseband signal processing chain.
12	Data Format	0: the data-words applied to Pin D<17:0> are expected to be coded as twos complement (default).
		1: the data-words applied to Pin D<17:0> are expected to be coded as offset binary.
11	PDCLK Enable	0: the PDCLK pin is disabled and forced to a static Logic 0 state; the internal clock signal continues to operate and provide timing to the data assembler.
		1: the internal PDCLK signal appears at the PDCLK pin (default).
10	PDCLK Invert	0: normal PDCLK polarity; Q-data associated with Logic 1, I-data with Logic 0 (default).
		1: inverted PDCLK polarity.
9	TxEnable Invert	0: normal TxENABLE polarity; Logic 0 is standby, Logic 1 is transmit (default).
		1: inverted TxENABLE polarity; Logic 0 is transmit, Logic 1 is standby.
8	Q-First Data Pairing	0: an I/Q data pair is delivered as I-data first, followed by Q-data (default).
		1: an I/Q data pair is delivered as Q-data first, followed by I-data.
7	Open	
6	Data Assembler Hold Last Value	Ineffective when CFR1<25:24> = 01b.
		0: when the TxENABLE pin is false, the data assembler ignores the input data and internally forces zeros on the baseband signal path (default).
		1: when the TxENABLE pin is false, the data assembler ignores the input data and internally forces the last value received on the baseband signal path.
5	Sync Timing Validation Disable	0: enables the setup and hold validation circuit to take a measurement; the measurement result appears at the SYNC_SMP_ERR pin; a Logic 1 at this pin indicates a potential setup/hold violation whereas a Logic 0 indicates that a setup/hold violation has not been detected; the measurement result is latched and held until this bit is set to a Logic 1.
		1: resets the setup and hold validation measurement circuit forcing the SYNC_SMP_ERR pin to a static Logic 0 condition (default); the measurement circuit is effectively disabled until this bit is restored to a Logic 0 state.
4:0	Open	

Control Function Register 3 (CFR3)
Address 0x02, four bytes are assigned to this register.

Table 20. Bit Descriptions for CFR3 Register

Bit (s)	Mnemonic	Description
31:30	Open	
29:28	DRV0	Controls REFCLK_OUT pin (see Table 6 for details); default is 01b.
27	Open	
26:24	VCO SEL	Selects frequency band of the VCO in the REFCLK PLL (see Table 7 for details); default is 111b.
23:22	Open	
21:19	I_{CP}	Selects the charge pump current in the REFCLK PLL (see Table 8 for details); default is 111b.
18:16	Open	
15	REFCLK Input Divider Bypass	0: input divider is selected (default).
		1: input divider is bypassed.
14	REFCLK Input Divider ResetB	0: input divider is reset.
		1: input divider operates normally (default).
13:9	Open	
8	PLL Enable	0: REFCLK PLL bypassed (default).
		1: REFCLK PLL enabled.
7:1	N	This 7-bit number is divide modulus of the REFCLK PLL feedback divider; default is 0000000b.
0	Open	

Auxiliary DAC Control Register
Address 0x03, four bytes are assigned to this register.

Table 21. Bit Descriptions for Auxiliary DAC Control Register

Bit(s)	Mnemonic	Description
31:8	Open	
7:0	FSC	This 8-bit number controls the full-scale output current of the main DAC (see the Auxiliary DAC section); default is 0xFF.

I/O Update Rate Register
Address 0x04, four bytes are assigned to this register. This register is effective without the need for an I/O update.

Table 22. Bit Descriptions for I/O Update Rate Register5

Bit(s)	Mnemonic	Description
31:0	I/O Update Rate	Ineffective unless CFR2<23> = 1. This 32-bit number controls the automatic I/O update rate (see the Automatic I/O Update section); default is 0xFFFFFFFF.

RAM Segment Register 0
Address 0x05, six bytes are assigned to this register. This register is effective without the need for an I/O update. This register is only active if CFR1<31> = 1 and there is a Logic 0-to-Logic 1 transition on the RT pin.

Table 23. Bit Descriptions for RAM Segment Register 0

Bit(s)	Mnemonic	Description
47:32	RAM Address Step Rate 0	This 16-bit number controls the rate at which the RAM state machine steps through the specified RAM address range.
31:22	RAM End Address 0	This 10-bit number identifies the ending address for the RAM state machine.
21:16	Open	
15:6	RAM Start Address 0	This 10-bit number identifies the starting address for the RAM state machine.
5:3	Open	
2:0	RAM Playback Mode 0	This 3-bit number identifies the playback mode for the RAM state machine (see Table 5).

RAM Segment Register 1

Address 0x06, six bytes are assigned to this register. This register is only active if CFR1<31> = 1 and there is a Logic 1 to Logic 0 transition on the RT pin.

Table 24. Bit Descriptions for RAM Segment Register 1

Bit(s)	Mnemonic	Description
47:32	RAM Address Step Rate 1	This 16-bit number controls the rate at which the RAM state machine steps through the specified RAM address range.
31:22	RAM End Address 1	This 10-bit number identifies the ending address for the RAM state machine.
21:16	Open	
15:6	RAM Start Address 1	This 10-bit number identifies the starting address for the RAM state machine.
5:3	Open	
2:0	RAM Playback Mode 1	This 3-bit number identifies the playback mode for the RAM state machine (see Table 5).

Amplitude Scale Factor (ASF) Register

Address 0x09, four bytes are assigned to this register. This register is only active if CFR1<9> = 1.

Table 25. Bit Descriptions for ASF Register

Bit(s)	Mnemonic	Description
31:16	Amplitude Ramp Rate	Ineffective unless CFR1<8> = 1. This 16-bit number controls the rate at which the OSK controller updates amplitude changes to the DDS.
15:2	Amplitude Scale Factor	If CFR1<8> = 0 and CFR1<23> = 0, then this 14-bit number is the amplitude scale factor for the DDS.
		If CFR1<8> = 0 and CFR1<23> = 1, then this 14-bit number is the amplitude scale factor for the DDS when the OSK pin is Logic 1.
		If CFR1<8> = 1, then this 14-bit number sets a ceiling on the maximum allowable amplitude scale factor for the DDS.
1:0	Amplitude Step Size	Ineffective unless CFR1<8> = 1. This 2-bit number controls the step size for amplitude changes to the DDS (see Table 9).

Multichip Sync Register

Address 0x0A, four bytes are assigned to this register.

Table 26. Bit Descriptions for the Multichip Sync Register

Bit(s)	Mnemonic	Description
31:28	Sync Validation Delay	Default is 0000b. This 4-bit number sets the timing skew (in ~75 ps increments) between SYSCLK and the delayed sync-in signal for the synchronization validation block in the synchronization receiver.
27	Sync Receiver Enable	0: synchronization clock receiver disabled (default).
		1: synchronization clock receiver enabled.
26	Sync Generator Enable	0: synchronization clock generator disabled (default).
		1: synchronization clock generator enabled.
25	Sync Generator Polarity	0: synchronization clock generator coincident with the rising edge of the system clock (default).
		1: synchronization clock generator coincident with the falling edge of the system clock.
24	Open	
23:18	Sync State Preset Value	Default is 000000b. This 6-bit number is the state that the internal clock generator assumes when it receives a sync pulse.
17:16	Open	
15:11	Sync Generator Delay	Default is 00000b. This 5-bit number sets the output delay (in ~75 ps increments) of the synchronization generator.
10:8	Open	
7:3	Sync Receiver Delay	Default is 00000b. This 5-bit number sets the delay input delay (in ~75 ps increments) of the synchronization receiver.
2:0	Open	

PROFILE REGISTERS

There are eight consecutive serial I/O addresses (0x0E to 0x15) dedicated to device profiles. All eight profile registers are either single tone profiles or QDUC profiles depending on the device operating mode specified by CFR1<25:24>. During operation, the active profile register is determined via the external PROFILE<2:0> pins.

Single tone profiles control: DDS frequency (32 bits), DDS phase offset (16 bits), and DDS amplitude scaling (14 bits).

QDUC profiles control: DDS frequency (32 bits), DDS phase offset (16 bits), output amplitude scaling (8 bits), CCI filter interpolation factor, inverse CCI bypass, and spectral invert. The QDUC profiles also selectively apply to the interpolating DAC operating mode: only output scaling, CCI filter interpolation factor, and inverse CCI bypass apply; all others (DDS frequency, output amplitude scaling, and spectral invert) are ignored.

Profile<7:0> Register—Single Tone

Address 0x0E to 0x15, eight bytes are assigned to this register.

Table 27. Bit Descriptions for Profile<7:0> Registers—Single Tone

Bit(s)	Mnemonic	Description
63:62	Open	
61:48	Amplitude Scale Factor	This 14-bit number controls the DDS output amplitude.
47:32	Phase Offset Word	This 16-bit number controls the DDS phase offset.
31:0	Frequency Tuning Word	This 32-bit number controls the DDS frequency.

Profile<7:0> Register—QDUC

Address 0x0E to 0x15, eight bytes are assigned to this register.

Table 28. Bit Descriptions for Profile<7:0> Registers—QDUC

Bit(s)	Mnemonic	Description
63:58	CC Interpolation Rate	This 6-bit number is the rate interpolation factor for the CCI filter.
57	Spectral Invert	0: the modulator output takes the form: $I(t) \times \cos(ct) - Q(t) \times \sin(ct)$.
		1: the modulator output takes the form: $I(t) \times \cos(ct) + Q(t) \times \sin(ct)$.
56	Inverse CCI Bypass	0: the inverse CCI filter is enabled.
		1: the inverse CCI filter is bypassed.
55:48	Output Scale Factor	This 8-bit number controls the output amplitude.
47:32	Phase Offset Word	This 16-bit number controls the DDS phase offset.
31:0	Frequency Tuning Word	This 32-bit number controls the DDS frequency.

RAM Register

Address 0x16, four bytes are assigned to this register.

Table 29. Bit Descriptions for RAM Register

Bit(s)	Mnemonic	Description
31:0	RAM Word	The number of 32-bit words written to RAM is defined by the start and end address in RAM Segment Register 0 or RAM Segment Register 1.

GPIO Configuration Register

Address 0x18, two bytes are assigned to this register.

Table 30. Bit Descriptions for GPIO Configuration Register

Bit(s)	Mnemonic	Description
15:0	GPIO Configuration	See the General-Purpose I/O (GPIO) Port section for details.

GPIO Data Register

Address 0x19, two bytes are assigned to this register.

Table 31. Bit Descriptions for GPIO Data Register

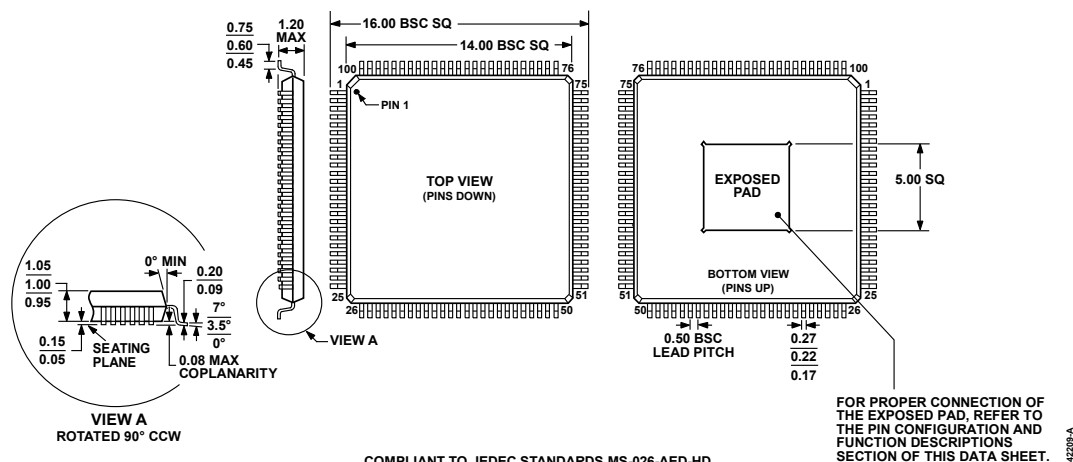| Bit(s)	Mnemonic	Description
15:0	GPIO Data	Read or write based on the contents of the GPIO Configuration register. See the General-Purpose I/O (GPIO) Port section for details.

OUTLINE DIMENSIONS

COMPLIANT TO JEDEC STANDARDS MS-026-AED-HD

Figure 65. 100-Lead Thin Quad Flat Package, Exposed Pad [TQFP_EP]
(SV-100-4)
Dimensions shown in millimeters

ORDERING GUIDE

Model[1]	Temperature Range	Package Description	Package Option
AD9957BSVZ	−40°C to +85°C	100-Lead Thin Quad Flat Package Exposed Pad [TQFP_EP]	SV-100-4
AD9957BSVZ-REEL	−40°C to +85°C	100-Lead Thin Quad Flat Package Exposed Pad [TQFP_EP]	SV-100-4
AD9957/PCBZ		Evaluation Board	

[1] Z = RoHS Compliant Part.

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